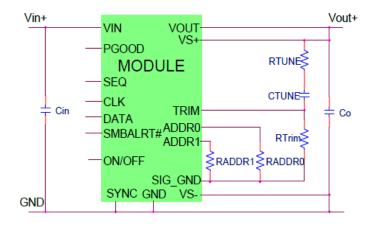


12A Digital PicoDLynx™: Non-Isolated DC-DC Power Modules

$3V_{dc} - s14.4V_{dc}$ input; $0.45V_{dc}$ to $5.5V_{dc}$ output; 12A Output Current





Description

The OmniOn Power™ 12A Digital PicoDLynx[™] power modules are nonisolated dc-dc converters that can deliver up to 12A of output current. These modules operate over a wide range of input voltage $(V_{IN} = 3V_{dc}-14.4V_{dc})$ and provide a precisely regulated output voltage from 0.45V_{dc} to 5.5V_{dc}, programmable via an external resistor and PMBus control. Features include a digital interface using the PMBus protocol, remote On/Off, adjustable output voltage, over current and over temperature protection. The PMBus interface supports a range of commands to both control and monitor the module. The module also includes the Tunable Loop[™] feature that allows the user to optimize the dynamic response of the converter to match the load with reduced amount of output capacitance leading to savings on cost and PWB area.

Applications

- Distributed power architectures
- Intermediate bus voltage applications
- Telecommunications equipment
- Servers and storage applications
- Networking equipment
- Industrial equipment



Features

- Compliant to RoHS Directive 2011/65/EU and amended Directive (EU) 2015/863.
- Compliant to REACH Directive (EC) No 1907/2006.
- Compatible in a Pb-free or SnPb reflow environment
- Compliant to IPC-9592 (September 2008), Category 2, Class II
- DOSA based
- Wide Input voltage range (3V_{dc}-14.4V_{dc})
- Output voltage programmable from 0.6V_{dc} to 5.5V_{dc} via external resistor. Digitally adjustable down to 0.45V_{dc}
- Digital interface through the PMBus^{™ #} protocol
- Tunable Loop™ to optimize dynamic output voltage response
- Flexible output voltage sequencing EZ-SEQUENCE

- Power Good signal
- Fixed switching frequency with capability of external synchronization
- Output overcurrent protection (non-latching)
- Overtemperature protection
- Remote On/Off
- Ability to sink and source current
- Cost efficient open frame design
- Small size: 12.2 mm x 12.2 mm x 8.5 mm (0.48 in x 0.48 in x 0.335 in)
- Wide operating temperature range
 [-40°C to 105°C(Ruggedized: -D), 85°C(Regular)]
- ANSI/UL* 62368-1 and CAN/CSA[†] C22.2 No. 62368-1 Recognized, DIN VDE[‡] 0868-1/A11:2017 (EN62368- 1:2014/A11:2017)
- ISO** 9001 and ISO 14001 certified manufacturing facilities

OmniOn Power is a trademark of OmniOn Power Inc. All other trademarks belong to their respective owners.

* UL is a registered trademark of Underwriters Laboratories, Inc.

- [‡] VDE is a trademark of Verband Deutscher Elektrotechniker e.V.
- ** ISO is a registered trademark of the International Organization of Standards
- [#] The PMBus name and logo are registered trademarks of the System Management Interface Forum (SMIF)

 $^{^{\}rm t}\,{\rm CSA}$ is a registered trademark of Canadian Standards Association.



Technical Specifications

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage	All	V _{IN}	-0.3	15	V
Continuous	All	VIN	-0.5	15	v
SEQ, SYNC, VS+	All			7	V
CLK, DATA, SMBALERT#	All			3.6	V
Operating Ambient Temperature	A 11	т.	(0	0.5	°C
(see Thermal Considerations section)	All	TA	-40	85	°C
Storage Temperature	All	T _{stg}	-55	125	°C

Electrical Specifications

Unless otherwise indicated, specifications apply overall operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Operating Input Voltage	All	V _{IN}	3	_	14.4	V _{dc}
Maximum Input Current	All				9	^
$(V_{IN} = 3V \text{ to } 14V, I_0 = I_{0, \max})$	All	I _{IN,max}			9	A _{dc}
Input No Load Current	$V_{O,set}$ = 0.6 V_{dc}	$I_{\rm IN,No\ load}$		52		mA
$(V_{IN} = 12V_{dc}, I_{O} = 0, module enabled)$	$V_{O,set}$ = 5 V_{dc}	$I_{\rm IN,No\ load}$		85		mA
Input Stand-by Current	All	I _{IN,stand-by}		6.5		mA
(V _{IN} = 12V _{dc} , module disabled)		IN,stand-by		0.5		
Inrush Transient	All	l²t			1	A ² s
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 1µH source impedance; V _{IN} =0 to 14V, Io= Io, max; See Test Configurations)	All			400		mA _{p-p}
Input Ripple Rejection (120Hz)	All			-55		dB
Output Voltage Set-point (with 0.1% tolerance for external resistor used to set output voltage)	All	V _{O, set}	-1.0		+1.0	% V _{O, set}
Output Voltage (Over all operating input voltage, resistive load, and temperature conditions until end of life)	All	V _{O, set}	-3.0	_	+3.0	$\% V_{O, set}$
Adjustment Range (selected by an external resistor) (Some output voltages may not be possible depending on the input voltage – see	All	Vo	0.6		5.5	V_{dc}
PMBus Adjustable Output Voltage Range	All	V _{O, adj}	-25	0	+25	% V _{O, set}
PMBus Output Voltage Adjustment Step Size	All		0.4			% V _{O, set}
Remote Sense Range	All				0.5	V _{dc}
Output Regulation (for $V_{O} \ge 2.5V_{dc}$)						
Line (V_{IN} = V_{IN} , min to V_{IN} , max)	All			_	+0.4	$\% V_{O, set}$
Load (I _O =I _{O, min} to I _{O, max})	All			—	10	mV
Output Regulation (for $V_0 < 2.5 V_{dc}$)						
Line (V _{IN} =V _{IN, min} to V _{IN, max})	All			—	5	mV
Load (I ₀ =I _{0, min} to I _{0, max})	All			—	10	mV
Temperature ($T_{ref}=T_{A,min}$ to $T_{A,max}$)	All			_	0.4	% V _{O, set}



Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
Output Ripple and Noise on nominal output						
$(V_{IN}=V_{IN, nom} \text{ and } I_0=I_{0, min} \text{ to } I_{0, max} C_0 = 0.1 \mu F // 22 \mu F$						
ceramic capacitors)						
Peak-to-Peak (5Hz to 20MHz bandwidth)	All			50	100	mV_{pk-pk}
RMS (5Hz to 20MHz bandwidth)	All			20	38	mV _{rms}
External Capacitance ¹						
Without the Tunable Loop™						
ESR≥1mΩ	All	C _{O, max}	22	—	47	μF
With the Tunable Loop™						
ESR ≥ 0.15 mΩ	All	C _{O, max}	22	—	1000	μF
$\text{ESR} \ge 10 \text{ m}\Omega$	All	C _{O, max}	22	—	5000	μF
Output Current (in either sink or source mode)	All	l _o	0		12	A _{dc}
Output Current Limit Inception (Hiccup Mode)	All			130		07.1
(current limit does not operate in sink mode)	All	I _{O, lim}		150		% I _{o,max}
Output Short-Circuit Current	All	1		0.92		
(V₀≤250mV) (Hiccup Mode)	All	l ₀ , _{s/c}		0.92		mA _{rms}
Efficiency	V _{O,set} = 0.6V _{dc}	η		76.4		%
V _{IN} = 12V _{dc} , T _A =25°C	$V_{O,set}$ = 1.2 V_{dc}	η		86.0		%
$I_0 = I_0 \max_{i} V_0 = V_{0,set}$	$V_{O,set}$ = 1.8 V_{dc}	η		89.9		%
	$V_{O,set}$ = 2.5 V_{dc}	η		92.2		%
	$V_{O,set}$ = 3.3 V_{dc}	η		93.6		%
	$V_{O,set}$ = 5.0 V_{dc}	η		95.4		%
Switching Frequency	All	f _{sw}	—	600	—	kHz
Frequency Synchronization	All					
Synchronization Frequency Range	All		510		720	kHz
High-Level Input Voltage	All	VIH	2.0			V
Low-Level Input Voltage	All	VIL			0.4	V
Input Current, SYNC	All	I _{SYNC}			100	nA
Minimum Pulse Width, SYNC	All	t _{sync}	100			ns
Maximum SYNC rise time	All	t _{sync_sh}	100			ns

¹ External capacitors may require using the new Tunable Loop[™] feature to ensure that the module is stable as well as getting the best transient response. See the Tunable Loop[™] section for details.

General Specifications

Parameter	Device	Min	Тур	Max	Unit
Calculated MTBF (I ₀ =0.8I _{0, max,} T _A =40°C) Telcordia Issue 2 Method 1 Case 3	All		21,774,843		Hours
Weight			2.23 (0.079)		g (oz.)



Feature Specifications

Unless otherwise indicated, specifications apply overall operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Device	Symbol	Min	Тур	Max	Unit
On/Off Signal Interface						
$(V_{IN}=VI_{N, min}$ to $V_{IN, max}$; open collector or						
equivalent,						
Signal referenced to GND)						
Device Code with no suffix – "4" Positive Logic (See						
Ordering Information)						
Logic High (Module ON)						
Input High Current	All	I _{IH}			1	mA
Input High Voltage	All	VIH	2.0		V _{IN, max}	V
Logic Low (Module OFF)	All	VIH	2.0		v IN, max	v
Input low Current	All	1			1	mA
				_		
Input Low Voltage	All	VIL	-0.2		0.6	V
Device Code with no suffix – Negative Logic (See						
OrderingInformation)						
(On/OFF pin is open collector/drain logic input with						
external pull-up resistor; signal referenced to GND)						
Logic High (Module OFF)						
Input High Current	All	Іін	—	_	1	mA
Input High Voltage	All	VIH	2.0		$V_{\text{IN,}\text{max}}$	V_{dc}
Logic Low (Module ON)						
Input low Current	All	I_{1L}	—	_	10	μA
Input Low Voltage	All	VIL	-0.2		0.6	V_{dc}
Turn-On Delay and Rise Times						
$(V_{IN}=V_{IN, nom}, I_O=I_{O, max}, V_O \text{ to within } \pm 1\% \text{ of steady state})$						
Case 1: On/Off input is enabled and then input						
power is applied (delay from instant at which V _{IN}	All	T _{delay}	_	1.1		msec
= V _{IN, min} until V _o =10% of V _o , set)		5				
Case 2: Input power is applied for at least one						
second and then the On/Off input is enabled	A 11	-		800		
(delay from instant at which Von/Off is enabled	All	T _{delay}		700		µsec
until V _o = 10% of V _{o, set})						
Output voltage Rise time (time for V _o to rise from	A 11			71		
10% of V _o , set to 90% of V _o , set)	All	T _{rise}	_	3.1		msec
Output voltage overshoot						
$(T_A = 25^{\circ}C V_{IN} = V_{IN, min} \text{ to } V_{IN, max}, I_O = I_O, min \text{ to } I_O, max)$					3.0	% V _{O, set}
With or without maximum external capacitance					0.0	70 • 0, set
Over Temperature Protection		1				
(See Thermal Considerations section)	All	T _{ref}		120		°C
PMBus Over Temperature Warning Threshold*	All	Twarn	1	130		°C
Tracking Accuracy (Power-Up: 2V/ms)	All	V _{SEQ} –V _o		130	100	mV
(Power-Op. 2V/ms) (Power-Down: 2V/ms)	All	V SEQ -Vo			100	111V
	All	$V_{\text{SEQ}} - V_{\text{o}}$			100	mV
(V _{IN, min} to V _{IN, max} ; I _{O, min} to I _{O, max} V _{SEQ} < VO)						
Input Undervoltage LOCKOUT	A !!		2 / 175		7 005	
Turn-on Threshold	All		2.475		3.025	V _{dc}
Turn-off Threshold	All		2.25		2.75	V _{dc}
Hysteresis	All			0.25		V _{dc}



Feature Specifications (Countinued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
PMBus Adjustable Input Under Voltage Lockout	All		2.5		14	V _{dc}
Thresholds	All		2.5		14	V dc
Resolution of Adjustable Input Under Voltage	All				500	mv
Threshold					500	1110
PGOOD (Power Good)						
Signal Interface Open Drain, $V_{supply} \leq 5V_{DC}$						
Overvoltage threshold for PGOOD ON	All			108		%V _{O, set}
Overvoltage threshold for PGOOD OFF	All			110		%V _{O, set}
Undervoltage threshold for PGOOD ON	All			92		%V _{O, set}
Undervoltage threshold for PGOOD OFF	All			90		%V _{O, set}
Pulldown resistance of PGOOD pin	All				50	Ω
Sink current capability into PGOOD pin	All				5	mA

* Over temperature Warning – Warning may not activate before alarm and unit may shutdown before warning

Digital Interface Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
PMBus Signal Interface Characteristics						
Input High Voltage (CLK, DATA)		VIH	2.1		3.6	V
Input Low Voltage (CLK, DATA)		VIL			0.8	V
Input high level current (CLK, DATA)		I _{IH}	-10		10	μA
Input low level current (CLK, DATA)		I _{IL}	-10		10	μA
Output Low Voltage (CLK, DATA, SMBALERT#)	I _{out} =2mA	Vol			0.4	V
Output high level open drain leakage current (DATA, SMBALERT#)	V _{OUT} =3.6V	I _{он}	0		10	μΑ
Pin capacitance		Co		0.7		рF
PMBus Operating frequency range	Slave Mode	F _{PMB}	10		400	kHz
	Receive Mode	+	0			
Data hold time	Transmit Mode	t _{hd:dat}	300			ns
Data setup time		t _{su:dat}	250			ns
Measurement System Characteristics				•		
Read delay time		t_{DLY}	153	192	231	μs
Output current measurement range		I _{RNG}	0		18	А
Output current measurement resolution		I _{RES}	62.5			mA
Output current measurement gain accuracy at 25°C (with I _{OUT,CORR})		I _{ACC}			±5	%
Output current measurement offset		I _{OFST}			0.1	А
V _{out} measurement range		V _{OUT(rng)}	0		5.5	V
Vout measurement resolution		V _{OUT(res)}		15.625		mV
V _{out} measurement accuracy		V _{OUT(ACC)}	-15		15	%
V _{out} measurement offset		V _{OUT(ofst)}	-3		3	%
V _{IN} measurement range		V _{IN(rng)}	3		14.4	V
V _{IN} measurement resolution		V _{IN(res)}		32.5		mV
V _{IN} measurement accuracy		VIN(ACC)	-15		15	%
V _{IN} measurement offset		V _{IN(ofst)}	-5.5		1.4	LSB



Characteristic Curves

The following figures provide typical characteristics for the 12A Digital PicoDLynx[™] at 0.6V₀ and 25°C.

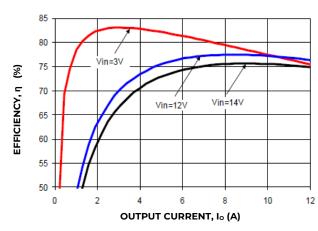


Figure 1. Converter Efficiency versus output current.

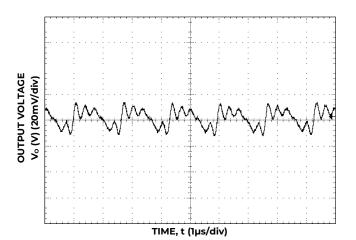
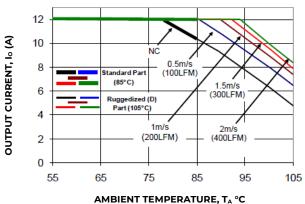


Figure 3. Typical output ripple and noise $(C_0=22\mu F \text{ ceramic}, V_{IN}=12V, I_0=I_{0,max}).$



AMBIENT TEMPERATURE, TA °C

Figure 2. Derating Output Current versus Ambient Temperature and Airflow.

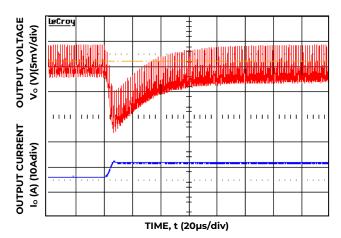
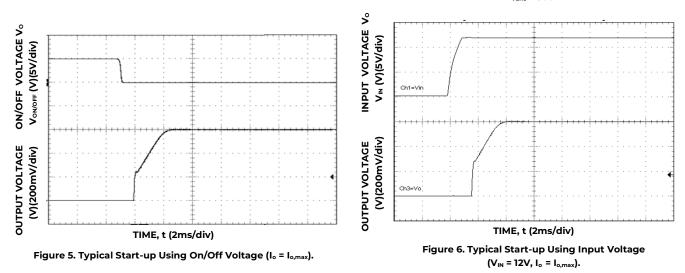


Figure 4. Transient Response to Dynamic Load Change from 50% to 100% at 12V_{in}, C_{out}=3x47µF+6x330µF, C_{Tune}=47nF, R_{Tune}=180ohm.



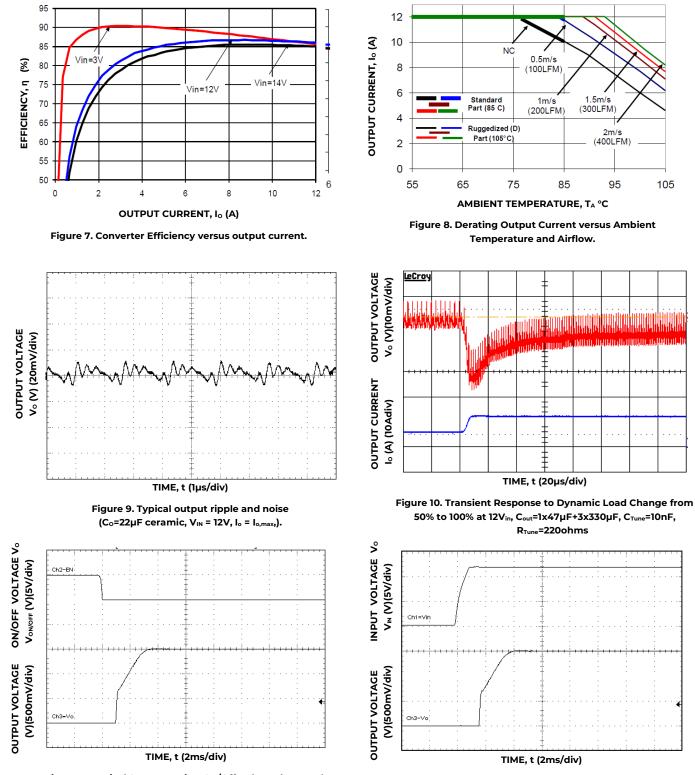


105

Technical Specifications (continued)

Characteristic Curves (continued)

The following figures provide typical characteristics for the 12A Digital PicoDLynx™ at 1.2V₀ and 25°C.









Characteristic Curves (continued)

The following figures provide typical characteristics for the 12A Digital PicoDLynx[™] at 1.8V₀ and 25°C.

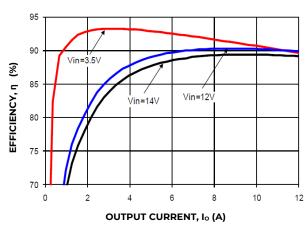


Figure 13. Converter Efficiency versus output current.

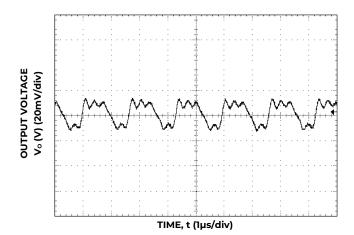


Figure 15. Typical output ripple and noise (C₀=22µF ceramic, V_{IN} = 12V, I₀ = I₀,max,).

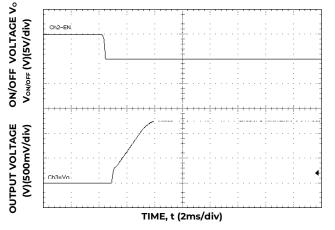


Figure 17. Typical Start-up Using On/Off Voltage (I_o = I_{o,max}).

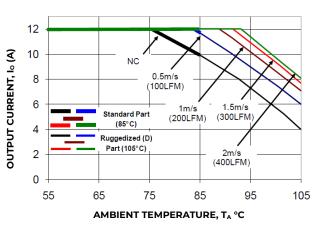


Figure 14. Derating Output Current versus Ambient Temperature and Airflow.

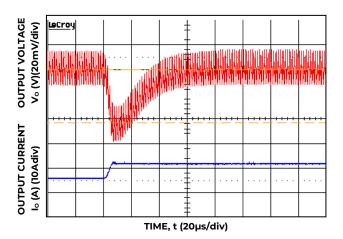
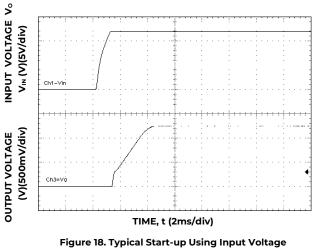
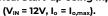


Figure 16. Transient Response to Dynamic Load Change from 50% to 100% at 12Vin, Cout=1x47µF+2x330µF, CTune=5600pF, RTune=270ohms.







NC

0.5m/s (100LFM)

75

1m/s (200LFM)

85

ŧ

‡

Ŧ TIME, t (20µs/div)

R_{Tune}=270 ohms.

TIME, t (2ms/div)

 $(V_{IN} = 12V, I_o = I_{o,max}).$

1.5m/s (300LFM)

2m/s (400LFM

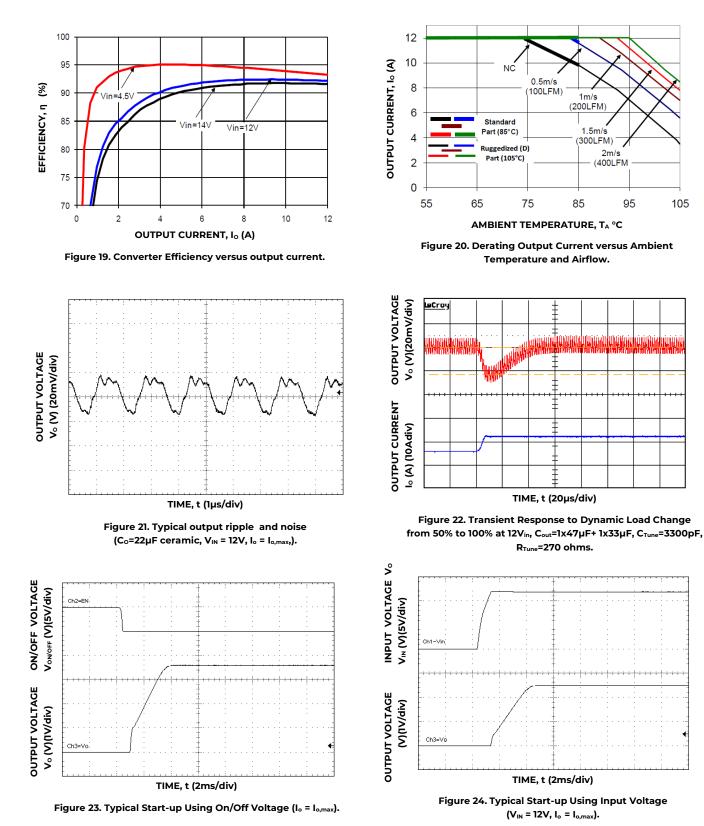
95

105

Technical Specifications (continued)

Characteristic Curves (continued)

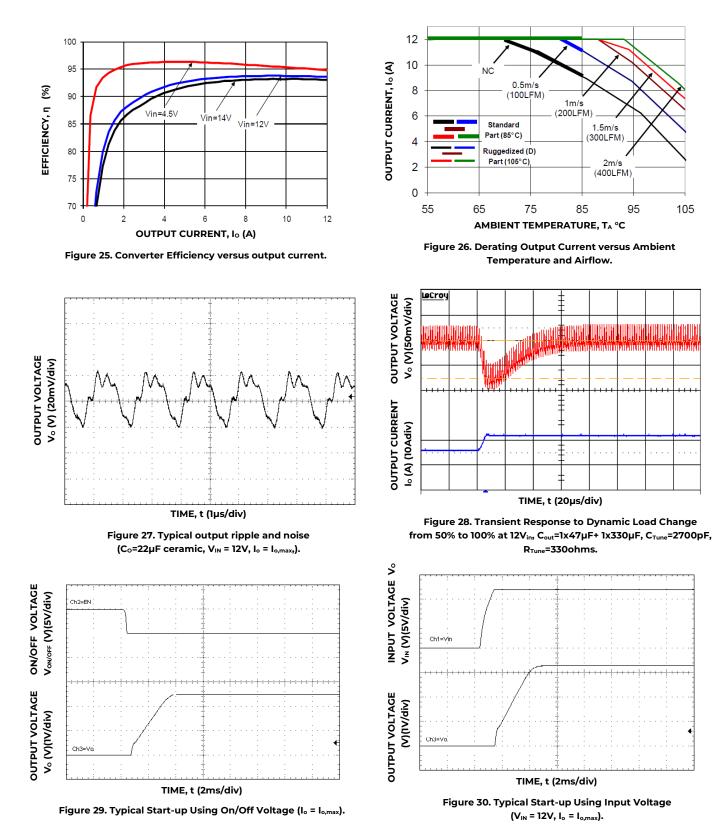
The following figures provide typical characteristics for the 12A Digital Pico DLynx™ at 2.5V₀ and 25°C.





Characteristic Curves (continued)

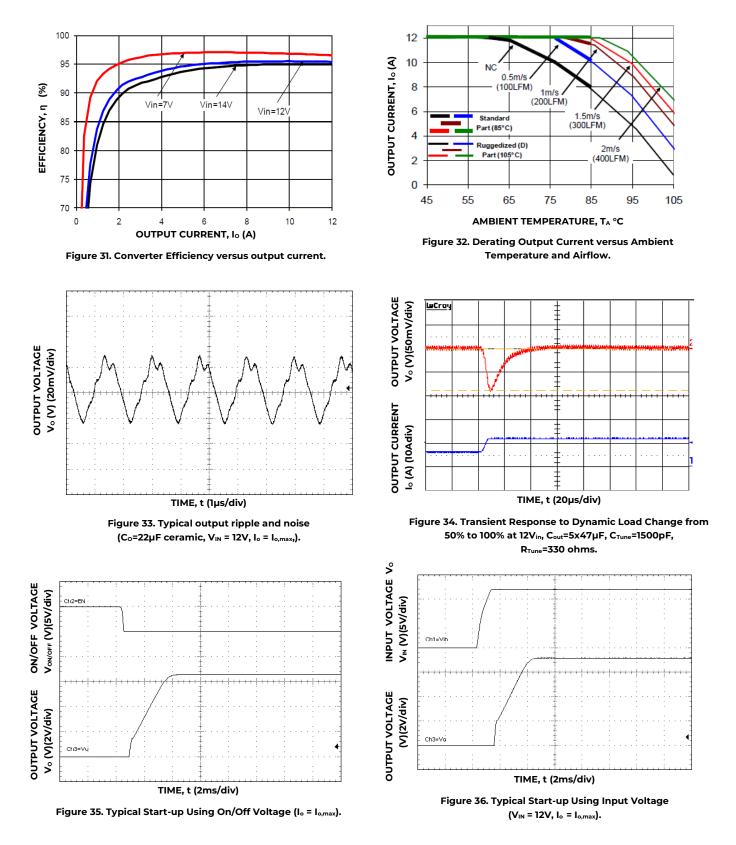
The following figures provide typical characteristics for the 12A Digital Pico DLynx[™] at 3.3V_o and 25°C.





Characteristic Curves (continued)

The following figures provide typical characteristics for the 12A Digital Pico DLynx™ at 5V₀ and 25°C.





Design Considerations

Input Filtering

The 12A Digital PicoDLynx[™] module should be connected to a low ac-impedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability.

To minimize input voltage ripple, ceramic capacitors are recommended at the input of the module. Figure 37 shows the input ripple voltage for various output voltages at 12A of load current with 2x22µF or 3x22µF ceramic capacitors and an input of 12V.

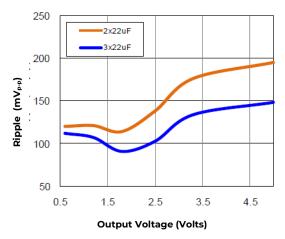


Figure 37. Input ripple voltage for various output voltages with $2x22 \ \mu F$ or $3x22 \ \mu F$ ceramic capacitors at the input (12A load). Input voltage is 12V.

Output Filtering

These modules are designed for low output ripple voltage and will meet the maximum output ripple specification with 0.1 μ F ceramic and 22 μ F ceramic capacitors at the output of the module. However, additional output filtering may be required by the system designer for a number of reasons. First, there may be a need to further reduce the output ripple and noise of the module. Second, the dynamic response characteristics may need to be customized to a particular load step change.

To reduce the output ripple and improve the dynamic response to a step load change, additional capacitance at the output can be used. Low ESR polymer and ceramic capacitors are recommended to improve the dynamic response of the module. Figure 38 provides output ripple information for different external capacitance values at various V₀ and a full load current of 12A. For stable operation of the module, limit the capacitance to less than the maximum output capacitance as specified in the electrical specification table. Optimal performance of the module can be achieved by using the Tunable Loop[™] feature described later in this data sheet.

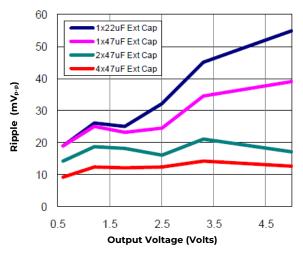


Figure 38. Output ripple voltage for various output voltages with external 1x22 μ F, 1x47 μ F, or 4x47 μ F ceramic capacitors at the output (12A load). Input voltage is 12V.

Safety Considerations

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL ANSI/UL* 62368-1 and CAN/CSA⁺ C22.2 No. 62368-1 Recognized, DIN VDE 0868-1/A11:2017 (EN62368-1:2014/A11:2017)

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV) or ESI, the input must meet SELV/ESI requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a slowblow fuse with a maximum rating of 15 A in the positive input lead.



Analog Feature Descriptions

Remote On/Off

The module can be turned ON and OFF either by using the ON/OFF pin (Analog interface) or through the PMBus interface (Digital). The module can be configured in a number of ways through the PMBus interface to react to the two ON/OFF inputs:

- Module ON/OFF can be controlled only through the analog interface (digital interface ON/OFF commands are ignored)
- Module ON/OFF can be controlled only through the PMBus interface (analog interface is ignored)
- Module ON/OFF can be controlled by either the analog or digital interface

The default state of the module (as shipped from the factory) is to be controlled by the analog interface only. If the digital interface is to be enabled, or the module is to be controlled only through the digital interface, this change must be made through the PMBus. These changes can be made and written to non-volatile memory on the module so that it is remembered for subsequent use.

Analog On/Off

The 12A Digital PicoDLynx[™] power modules feature an On/Off pin for remote On/Off operation. Two On/Off logic options are available. In the Positive Logic On/Off option, (device code suffix "4" – see Ordering Information), the module turns ON during a logic High on the On/Off pin and turns OFF during a logic Low. With the Negative Logic On/Off option, (no device code suffix, see Ordering Information), the module turns OFF during logic High and ON during logic Low. The On/Off signal should be always referenced to ground. For either On/Off logic option, leaving the On/ Off pin disconnected will turn the module ON when input voltage is present.

For positive logic modules, the circuit configuration for using the On/Off pin is shown in Figure 39. When the external transistor Q2 is in the OFF state, the internal transistor Q1 is turned ON, and the internal PWM #Enable signal is pulled low causing the module to be ON. When transistor Q2 is turned ON, the On/Off pin is pulled low and the module is OFF. A suggested value for R_{pullup} is 20k Ω . For negative logic On/Off modules, the circuit configuration is shown in Fig. 40. The On/Off pin should be pulled high with an external pull-up resistor (suggested value for the 3V to 14V input range is 20Kohms). When transistor Q2 is in the OFF state, the On/Off pin is pulled high, transistor Q1 is turned ON and the module is OFF. To turn the module ON, Q2 is turned ON pulling the On/Off pin low, turning transistor Q1 OFF resulting in the PWM Enable pin going high.

Digital On/Off

Please see the Digital Feature Descriptions section

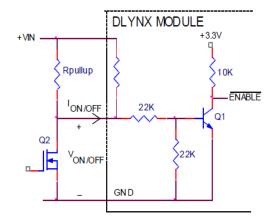


Figure 39. Circuit configuration for using positive On/Off logic.

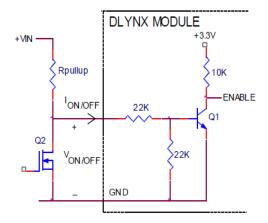


Figure 40. Circuit configuration for using negative On/Off logic. Monotonic Start-up and Shutdown

The module has monotonic start-up and shutdown behavior for any combination of rated input voltage, output current and operating temperature range.

Startup into Pre-biased Output

The module can start into a prebiased output as long as the prebias voltage is 0.5V less than the set output voltage.



Analog Output Voltage Programming

The output voltage of the module is programmable to any voltage from 0.6_{dc} to 5.5V_{dc} by connecting a resistor between the Trim and SIG_GND pins of the module. Certain restrictions apply on the output voltage set point depending on the input voltage. These are shown in the Output Voltage vs. Input Voltage Set Point Area plot in Fig. 41. The Upper Limit curve shows that for output voltages lower than 1V, the input voltage must be lower than the maximum of 14.4V. The Lower Limit curve shows that for output voltages higher than 0.6V, the input voltage needs to be larger than the minimum of 3V.

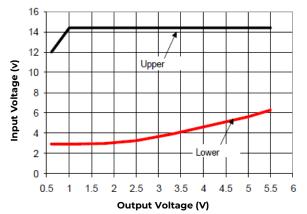


Figure 41. Output Voltage vs. Input Voltage Set Point Area plot showing limits where the output voltage can be set for different input voltages.

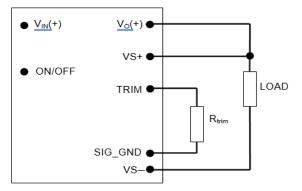


Figure 42. Circuit configuration for programming output voltage using an external resistor.

Caution – Do not connect SIG_GND to GND elsewhere in the layout Without an external resistor between Trim and SIG_GND pins, the output of the module will be 0.6V_{dc}.To calculate the value of the trim resistor, R_{trim} for a desired output voltage, should be as per the following equation:

$$R_{\text{trim}} = \left[\begin{array}{c} 12 \\ (V_{o} - 0.6) \end{array} \right] K\Omega$$

 R_{trim} is the external resistor in $k\Omega$

 V_{\circ} is the desired output voltage.

Table 1 provides R_{trim} values required for some common output voltages.

V ₀ , set (V)	R _{trim} (KΩ)
0.6	Open
0.9	40
1.0	30
1.2	20
1.5	13.33
1.8	10
2.5	6.316
3.3	4.444
5.0	2.727

Table 1

Digital Output Voltage Adjustment

Please see the Digital Feature Descriptions section.

Remote Sense

The power module has a Remote Sense feature to minimize the effects of distribution losses by regulating the voltage between the sense pins (VS+ and VS-). The voltage drop between the sense pins and the V_{OUT} and GND pins of the module should not exceed 0.5V.

Analog Voltage Margining

Output voltage margining can be implemented in the module by connecting a resistor, R_{margin-up}, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, R_{margin-down}, from the Trim pin to output pin for margining-down. Figure 43 shows the circuit configuration for output voltage margining. The POL Programming Tool, available at **omnionpower.com** under the Downloads section, also calculates the values of R_{margin-up} and R_{margin-down} for a specific output voltage and % margin. Please consult your local OmniOn Power[™] technical representative for additional details.



Analog Voltage Margining (continued)

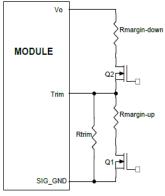


Figure 43. Circuit Configuration for margining Output voltage.

Digital Output Voltage Margining

Please see the Digital Feature Descriptions section.

Output Voltage Sequencing

The power module includes a sequencing feature, EZ -SEQUENCE that enables users to implement various types of output voltage sequencing in their applications. This is accomplished via an additional sequencing pin. When not using the sequencing feature, leave it unconnected.

The voltage applied to the SEQ pin should be scaled down by the same ratio as used to scale the output voltage down to the reference voltage of the module. This is accomplished by an external resistive divider connected across the sequencing voltage before it is fed to the SEQ pin as shown in Fig. 44. In addition, a small capacitor (suggested value 100pF) should be connected across the lower resistor R1.

For all DLynx modules, the minimum recommended delay between the ON/OFF signal and the sequencing signal is 10ms to ensure that the module output is ramped up according to the sequencing signal. This ensures that the module soft-start routine is completed before the sequencing signal is allowed to ramp up.

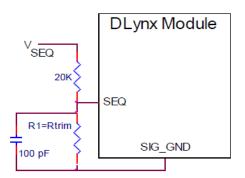


Figure 44. Circuit showing connection of the sequencing signal to the SEQ pin.

When the scaled down sequencing voltage is applied to the SEQ pin, the output voltage tracks this voltage until the output reaches the set-point voltage. The final value of the sequencing voltage must be set higher than the set-point voltage of the module. The output voltage follows the sequencing voltage on a one-to-one basis. By connecting multiple modules together, multiple modules can track their output voltages to the voltage applied on the SEQ pin.

The module's output can track the SEQ pin signal with slopes of up to 0.5V/msec during power-up or power-down.

To initiate simultaneous shutdown of the modules, the SEQ pin voltage is lowered in a controlled manner. The output voltage of the modules tracks the voltages below their set- point voltages on a one-to-one basis. A valid input voltage must be maintained until the tracking and output voltages reach ground potential.

Note that in all digital DLynx series of modules, the PMBus Output Undervoltage Fault will be tripped when sequencing is employed. This will be detected using the STATUS_WORD and STATUS_VOUT PMBus commands. In addition, the SMBALERT# signal will be asserted low as occurs for all faults and warnings. To avoid the module shutting down due to the Output Undervoltage Fault, the module must be set to continue operation without interruption as the response to this fault (see the description of the PMBus command VOUT_UV_FAULT_RESPONSE for additional information).

Overcurrent Protection

To provide protection in a fault (output overload) condition, the unit is equipped with internal currentlimiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range.

Digital Adjustable overcurrent Warning

Please see the Digital Feature Descriptions section.



Overtemperature Protection

To provide protection in a fault condition, the unit is equipped with a thermal shutdown circuit. The unit will shut down if the overtemperature threshold of $150^{\circ}C(typ)$ is exceeded at the thermal reference point $T_{ref.}$ Once the unit goes into thermal shutdown it will then wait to cool before attempting to restart.

Digital Temperature Status via PMBus

Please see the Digital Feature Descriptions section.

Digitally Adjustable Output Over and Under Voltage Protection

Please see the Digital Feature Descriptions section.

Input Undervoltage Lockout

At input voltages below the input undervoltage lockout limit, the module operation is disabled. The module will begin to operate at an input voltage above the undervoltage lockout turn-on threshold.

Digitally Adjustable Input Undervoltage Lockout

Please see the Digital Feature Descriptions section.

Digitally Adjustable Power Good Thresholds

Please see the Digital Feature Descriptions section.

Synchronization

The module switching frequency can be synchronized to a signal with an external frequency within a specified range. Synchronization can be done by using the external signal applied to the SYNC pin of the module as shown in Fig. 45, with the converter being synchronized by the rising edge of the external signal. The Electrical Specifications table specifies the requirements of the external SYNC signal. If the SYNC pin is not used, the module should free run at the default switching frequency. **If synchronization is not being used, connect the SYNC pin to GND.**

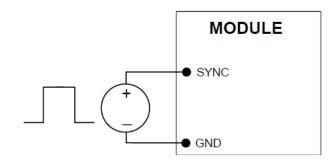


Figure 45. External source connections to synchronize switching frequency of the module.

Measuring Output Current, Output Voltage and Input Voltage

Please see the Digital Feature Descriptions section.

Dual Layout

Identical dimensions and pin layout of Analog and Digital PicoDLynx modules permit migration from one to the other without needing to change the layout. To support this, 2 separate Trim Resistor locations have to be provided in the layout. As shown in Fig. 46, for the digital modules, the resistor is connected between the TRIM pad and SGND and in the case of the analog module it is connected between TRIM and GND.

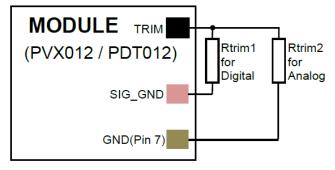


Figure 46. Connections to support either Analog or Digital PicoDLynx on the same layout.

Caution – For digital modules, do not connect SIG_GND to GND elsewhere in the layout

Tunable Loop™

The module has a feature that optimizes transient response of the module called Tunable LoopTM.

External capacitors are usually added to the output of the module for two reasons: to reduce output ripple and noise (see Figure 38) and to reduce output voltage deviations from the steady-state value in the presence of dynamic load current changes. Adding external capacitance however affects the voltage control loop of the module, typically causing the loop to slow down with sluggish response. Larger values of external capacitance could also cause the module to become unstable.

The Tunable Loop[™] allows the user to externally adjust the voltage control loop to match the filter network connected to the output of the module. The Tunable Loop[™] is implemented by connecting a series R-C between the VS+ and TRIM pins of the module, as shown in Fig. 47. This R-C allows the user to externally adjust the voltage loop feedback compensation of the module.



Tunable Loop™ (continued)

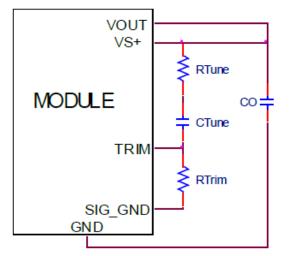


Figure. 47. Circuit diagram showing connection of R_{TUNE} and C_{TUNE} to tune the control loop of the module.

Recommended values of R_{TUNE} and C_{TUNE} for different output capacitor combinations are given in Table 2. Table 2 shows the recommended values of RTUNE and C_{TUNE} for different values of ceramic output capacitors up to 1000uF that might be needed for an application to meet output ripple and noise requirements. Selecting R_{TUNE} and C_{TUNE} according to Table 2 will ensure stable operation of the module. In applications with tight output voltage limits in the presence of dynamic current loading, additional output capacitance will be required. Table 3 lists recommended values of R_{TUNE} and C_{TUNE} in order to meet 2% output voltage deviation limits for some common output voltages in the presence of a 6A to 12A step change (50% of full load), with an input voltage of 12V.

Please contact your OmniOn Power™ technical representative to obtain more details of this feature as well as for guidelines on how to select the right value of external R-C to tune the module for best transient performance and stable operation for other output capacitance values

C。	1x47µF	2x47µF	4x47µF	6x47µF	10x47µF	20x47µF
RTUNE	330	330	330	330	220	180
CTUNE	100pF	560pF	1500pF	2200pF	10nF	6800pF

Table 2. General recommended values of R_{TUNE} and C_{TUNE} for V_{in} =12V and various external ceramic capacitor combinations.

V.	5V	3.3V	2.5V	1.8V	1.2V	0.6V
		1x47µF	3x47µF	1x47µF	1x47µF	3x47µF
~		+	+	+	+	+
C.		330µF		2x330µF	3x330µF	6x330µF
		Polymer	Polymer	Polymer	Polymer	Polymer
RTUNE	330	330	270	270	220	180
CTUNE	1500pF	2700pF	3300pF	5600pF	10nF	47nF
ΔV	99mV	58mV	47mV	34mV	24mV	12mV

Table 3. Recommended values of R_{TUNE} and C_{TUNE} to obtain transient deviation of 2% of V_{out} for a 6A step load with V_{in} =12V.

Note: The capacitors used in the Tunable Loop tables are 47 μ F/3 m Ω ESR ceramic and 330 μ F/12 m Ω ESR polymer capacitors.

Digital Feature Descriptions

PMBus Interface Capability

The 12A Digital PicoDLynx[™] power modules have a PMBus interface that supports both communication and control. The PMBus Power Management Protocol Specification can be obtained from <u>www.pmbus.org.</u> The modules support a subset of version 1.1 of the specification (see Table 6 for a list of the specific commands supported). Most module parameters can be programmed using PMBus and stored as defaults for later use.

All communication over the module PMBus interface must support the Packet Error Checking (PEC) scheme. The PMBus master must generate the correct PEC byte for all transactions, and check the PEC byte returned by the module.

The module also supports the SMBALERT# response protocol whereby the module can alert the bus master if it wants to talk. For more information on the SMBus alert response protocol, see the System Management Bus (SMBus) specification.

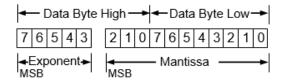
The module has non-volatile memory that is used to store configuration settings. Not all settings programmed into the device are automatically saved into this non-volatile memory, only those specifically identified as capable of being stored can be saved (see Table 6 for which command parameters can be saved to non-volatile storage).

PMBus Data Format

For commands that set thresholds, voltages or report such quantities, the module supports the "Linear" data format among the three data formats supported by PMBus. The Linear Data Format is a two byte value with an 11-bit, two's complement mantissa and a 5-bit, two's complement exponent. The format of the two data bytes is shown below:



PMBus Data Format (continued)



The value is of the number is then given by

Value = Mantissa x 2 Exponent

PMBus Addressing

The power module can be addressed through the PMBus using a device address. The module has 64 possible addresses (0 to 63 in decimal) which can be set using resistors connected from the ADDR0 and ADDR1 pins to SIG_GND. Note that some of these addresses (0, 1, 2, 3, 4, 5, 6, 7, 8, 12, 40, 44, 45, 55 in decimal) are reserved according to the SMBus specifications and may not be useable. The address is set in the form of two octal (0 to 7) digits, with each pin setting one digit. The ADDR1 pin sets the high order digit and ADDR0 sets the low order digit. The resistor values suggested for each digit are shown in Table 4 (1% tolerance resistors are recommended). Note that if either address resistor value is outside the range specified in Table 4, the module will respond to address 127

Digit	Resistor Value (KΩ)
0	10
1	15.4
2	23.7
3	36.5
4	54.9
5	84.5
6	130
7	200
•	Table 4

The user must know which I²C addresses are reserved in a system for special functions and set the address of the module to avoid interfering with other system operations. Both 100kHz and 400kHz bus speeds are supported by the module. Connection for the PMBus interface should follow the High Power DC specifications given in section 3.1.3 in the SMBus specification V2.0 for the 400kHz bus speed or the Low Power DC specifications in section 3.1.2. The complete SMBus specification is available from the SMBus web site, **SMBus.org**

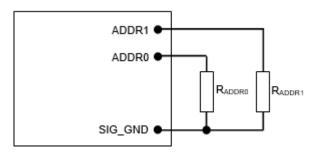


Figure 48. Circuit showing connection of resistors used to set the PMBus address of the module.

PMBus Enabled On/Off

The module can also be turned on and off via the PMBus interface. The OPERATION command is used to actually turn the module on and off via the PMBus, while the ON_OFF_CONFIG command configures the combination of analog ON/OFF pin input and PMBus commands needed to turn the module on and off. Bit [7] in the OPERATION command data byte enables the module, with the following functions:

0 : Output is disabled

1: Output is enabled

This module uses the lower five bits of the ON_OFF_CONFIG data byte to set various ON/OFF options as follows:

Bit Position	4	3	2	1	0
Access	r/w	r/w	r/w	r/w	r
Function	PU	CMD	CPR	POL	СРА
Default Value	1	0	1	1	1

PU: Sets the default to either operate any time input power is present or for the ON/OFF to be controlled by the analog ON/OFF input and the PMBus OPERATION command. This bit is used together with the CP, CMD and ON bits to determine startup.

Bit Value	Action
0	Module powers up any time power is present regardless of state of the analog ON/OFF pin
1	Module does not power up until commanded by the analog ON/OFF pin and the OPERATION command as programmed in bits [2:0] of the ON_OFF_CONFIG register.

CMD: The CMD bit controls how the device responds to the OPERATION command.





PMBus Enabled On/Off (continued)

Bit Value	Action
	Module ignores the ON bit in the OPERATION command
	Module responds to the ON bit in the OPERATION command

CPR: Sets the response of the analog ON/OFF pin. This bit is used together with the CMD, PU and ON bits to determine startup.

Bit Value	Action
0	Module ignores the analog ON/OFF pin, i.e. ON/OFF is only controlled through the PMBUS via the OPERATION command
1	Module requires the analog ON/OFF pin to be asserted to start the unit

PMBus Adjustable Soft Start Rise Time

The soft start rise time can be adjusted in the module via PMBus. When setting this parameter, make sure that the charging current for output capacitors can be delivered by the module in addition to any load current to avoid nuisance tripping of the overcurrent protection circuitry during startup. The TON_RISE command sets the rise time in ms, and allows choosing soft start times between 600µs and 9ms, with possible values listed in Table 5. Note that the exponent is fixed at -4 (decimal) and the upper two bits of the mantissa are also fixed at 0.

Rise Time	Exponent	Mantissa
600µs	11100	0000001010
900µs	11100	0000001110
1.2ms	11100	0000010011
1.8ms	11100	00000011101
2.7ms	11100	00000101011
4.2ms	11100	00001000011
6.0ms	11100	00001100000
9.0ms	11100	00010010000

Table 5

Output Voltage Adjustment Using the PMBus

The VOUT_SCALE_LOOP parameter is important for a number of PMBus commands related to output voltage trimming, margining, over/under voltage protection and the PGOOD thresholds. The output voltage of the module is set as the combination of the voltage divider formed by R_{Trim} and a 20k Ω upper divider resistor inside the module, and the internal reference voltage of the module. The reference

voltage V_{REF} is nominally set at 600mV, and the output regulation voltage is then given by

$$V_{OUT} = \left[\frac{20000 + R_{Trim}}{R_{Trim}} \right] X V_{REF}$$

Hence the module output voltage is dependent on the value of R_{Trim} which is connected external to the module. The information on the output voltage divider ratio is conveyed to the module through the VOUT_SCALE_LOOP parameter which is calculated as follows:

VOUT_SCALE_LOOP =
$$\frac{R_{Trim}}{20000 + R_{Trim}}$$

The VOUT_SCALE_LOOP parameter is specified using the "Linear" format and two bytes. The upper five bits [7:3] of the high byte are used to set the exponent which is fixed at -9 (decimal). The remaining three bits of the high byte [2:0] and the eight bits of the lower byte are used for the mantissa. The default value of the mantissa is 0010000000 corresponding to 256 (decimal), corresponding to a divider ratio of 0.5. The maximum value of the mantissa is 512 corresponding to a divider ratio of 1. Note that the resolution of the VOUT_SCALE_LOOP command is 0.2%.

When PMBus commands are used to trim or margin the output voltage, the value of V_{REF} is what is changed inside the module, which in turn changes the regulated output voltage of the module.

The nominal output voltage of the module can be adjusted with a minimum step size of 0.4% over a ±25% range from nominal using the VOUT_TRIM command over the PMBus.

The VOUT_TRIM command is used to apply a fixed offset voltage to the output voltage command value using the "Linear" mode with the exponent fixed at –10 (decimal). The value of the offset voltage is given by

This offset voltage is added to the voltage set through the divider ratio and nominal V_{REF} to produce the trimmed output voltage. The valid range in two's complement for this command is -4000h to 3FFFh. The high order two bits of the high byte must both be either 0 or 1.



Output Voltage Adjustment Using the PMBus (continued)

If a value outside of the +/-25% adjustment range is given with this command, the module will set it's output voltage to the nominal value (as if VOUT_TRIM had been set to 0), assert SMBALRT#, set the CML bit in STATUS_BYTE and the invalid data bit in STATUS_CML.

Output Voltage Margining Using the PMBus

The module can also have its output voltage margined via PMBus commands. The command VOUT_MARGIN_HIGH sets the margin high voltage, while the command VOUT_MARGIN_LOW sets the margin low voltage. Both the VOUT_MARGIN_HIGH and VOUT_MARGIN_LOW commands use the "Linear" mode with the exponent fixed at –10 (decimal). Two bytes are used for the mantissa with the upper bit [7] of the high byte fixed at 0. The actual margined output voltage is a combination of the VOUT_MARGIN_HIGH or VOUT_MARGIN_LOW and the VOUT_TRIM values as shown below.

V_{OUT(MH)} = (VOUT_MARGIN_HIGH+ VOUT_TRIM) X 2⁻¹⁰

V_{OUT(ML)} = (VOUT_MARGIN_LOW+ VOUT_TRIM) X 2⁻¹⁰

Note that the sum of the margin and trim voltages cannot be outside the ±25% window around the nominal output voltage. The data associated with VOUT_MARGIN_HIGH and VOUT_MARGIN_LOW can be stored to non-volatile memory using the STORE_DEFAULT_ALL command.

The module is commanded to go to the margined high or low voltages using the OPERATION command. Bits [5:2] are used to enable margining as follows:

00XX : Margin Off 0101 : Margin Low (Ignore Fault) 0110 : Margin Low (Act on Fault) 1001 : Margin High (Ignore Fault) 1010 : Margin High (Act on Fault)

PMBus Adjustable Overcurrent Warning

The module can provide an overcurrent warning via the PMBus. The threshold for the overcurrent warning can be set using the parameter

IOUT_OC_WARN_LIMIT. This command uses the "Linear" data format with a two byte data word where the upper five bits [7:3] of the high byte represent the exponent and the remaining three bits of the high byte [2:0] and the eight bits in the low byte represent the mantissa. The exponent is fixed at –1 (decimal). The upper six bits of the mantissa are fixed at 0 while the lower five bits are programmable. For production codes after April 2013, the value for IOUT_OC_WARN_LIMIT will be fixed at 14.5A. For earlier production codes the actual value for IOUT_OC_WARN_LIMIT will vary from module to module due to calibration during production testing. The resolution of this warning limit is 500mA. The value of the IOUT_OC_WARN_LIMIT can be stored to non-volatile memory using the STORE_DEFAULT_ALL command.

Temperature Status via PMBus

The module can provide information related to temperature of the module through the STATUS_TEMPERATURE command. The command returns information about whether the pre-set over temperature fault threshold and/or the warning threshold have been exceeded.

PMBus Adjustable Output Over and Under Voltage Protection

The module has output over and under voltage protection capability. The PMBus command VOUT_OV_FAULT_LIMIT is used to set the output over voltage threshold from four possible values: 108%, 110%, 112% or 115% of the commanded output voltage. The command VOUT_UV_FAULT_LIMIT sets the threshold that causes an output under voltage fault and can also be selected from four possible values: 92%, 90%, 88% or 85%. The default values are 112% and 88% of commanded output voltage. Both commands use two data bytes formatted as two's complement binary integers. The "Linear" mode is used with the exponent fixed to –10 (decimal) and the effective over or under voltage trip points given by:

V_{OUT(OV_REQ)} = (VOUT_OV_FAULT_LIMIT) X 2⁻¹⁰

 $V_{OUT(UV_{REQ})} = (VOUT_UV_FAULT_LIMIT) \times 2^{-10}$

Values within the supported range for over and undervoltage detection thresholds will be set to the nearest fixed percentage. Note that the correct value for VOUT_SCALE_LOOP must be set in the module for the correct over or under voltage trip points to be calculated.

Page 21



PMBus Adjustable Output Over and Under Voltage Protection (continued)

In addition to adjustable output voltage protection, the 12A Digital PicoDLynx[™] module can also be programmed for the response to the fault. The VOUT_OV_FAULT RESPONSE and VOUT_UV_FAULT_RESPONSE commands specify the response to the fault. Both these commands use a single data byte with the possible options as shown below

- Continue operation without interruption (Bits [7:6]= 00, Bits [5:3] = xxx)
- Continue for four switching cycles and then shut down if the fault is still present, followed by no restart or continuous restart (Bits [7:6] = 01, Bits [5:3] = 000 means no restart, Bits [5:3] = 111 means continuous restart)
- Immediate shut down followed by no restart or continuous restart (Bits [7:6] = 10, Bits [5:3] = 000 means no restart, Bits [5:3] = 111 means continuous restart).
- Module output is disabled when the fault is present and the output is enabled when the fault no longer exists (Bits [7:6] = 11, Bits [5:3] = xxx).

Note that separate response choices are possible for output over voltage or under voltage faults.

PMBus Adjustable Input Undervoltage Lockout

The module allows adjustment of the input under voltage lockout and hysteresis. The command VIN_ON allows setting the input voltage turn on threshold, while the VIN_OFF command sets the input voltage turn off threshold. For the VIN_ON command, possible values are 2.75V, and 3V to 14V in 0.5V steps. For the VIN_OFF command, possible values are 2.5V to 14V in 0.5V steps. If other values are entered for either command, they will be mapped to the closest of the allowed values.

VIN_ON must be set higher than VIN_OFF. Attempting to write either VIN_ON lower than VIN_OFF or VIN_OFF higher than VIN_ON results in the new value being rejected, SMBALERT being asserted along with the CML bit in STATUS_BYTE and the invalid data bit in STATUS_CML.

Both the VIN_ON and VIN_OFF commands use the "Linear" format with two data bytes. The upper five bits represent the exponent (fixed at -2) and the remaining 11 bits represent the mantissa. For the mantissa, the four most significant bits are fixed at 0.

Power Good

The module provides a Power Good (PGOOD) signal that is implemented with an open-drain output to indicate that the output voltage is within the regulation limits of the power module. The PGOOD signal will be de-asserted to a low state if any condition such as overtemperature, overcurrent or loss of regulation occurs that would result in the output voltage going outside the specified thresholds. The PGOOD thresholds are user selectable via the PMBus (the default values are as shown in the Feature Specifications Section). Each threshold is set up symmetrically above and below the nominal value. The POWER_GOOD_ON command sets the output voltage level above which PGOOD is asserted (lower threshold). For example, with a 1.2V nominal output voltage, the POWER_GOOD_ON threshold can set the lower threshold to 1.14 or 1.1V. Doing this will automatically set the upper thresholds to 1.26 or 1.3V.

The POWER_GOOD_OFF command sets the level below which the PGOOD command is de-asserted. This command also sets two thresholds symmetrically placed around the nominal output voltage. Normally, the POWER_GOOD_ON threshold is set higher than the POWER_GOOD_OFF threshold.

Both POWER_GOOD_ON and POWER_GOOD_OFF commands use the "Linear" format with the exponent fixed at –10 (decimal). The two thresholds are given by

V_{OUT(PGOOD_ON)} = (POWER_GOOD_ON) X 2⁻¹⁰

V_{OUT(PGOOD_OFF)} = (POWER_GOOD_OFF) X 2⁻¹⁰

Both commands use two data bytes with bit [7] of the high byte fixed at 0, while the remaining bits are r/w and used to set the mantissa using two's complement representation. Both commands also use the VOUT_SCALE_LOOP parameter so it must be set correctly. The default value of POWER_GOOD_ON is set at 1.1035V and that of the POWER_GOOD_OFF is set at 1.08V. The values associated with these commands can be stored in non-volatile memory using the STORE_DEFAULT_ALL command.

The PGOOD terminal can be connected through a pullup resistor (suggested value 100K Ω) to a source of 5V_{DC} or lower.





Measurement of Output Current, Output Voltage and Input Voltage

The module is capable of measuring key module parameters such as output current and voltage and input voltage and providing this information through the PMBus interface. Roughly every 200µs, the module makes 16 measurements each of output current, voltage and input voltage. Average values of of these 16 measurements are then calculated and placed in the appropriate registers. The values in the registers can then be read using the PMBus interface.

Measuring Output Current Using the PMBus

The module measures current by using the inductor winding resistance as a current sense element. The inductor winding resistance is then the current gain factor used to scale the measured voltage into a current reading. This gain factor is the argument of the IOUT_CAL_GAIN command, and consists of two bytes in the linear data format. The exponent uses the upper five bits [7:3] of the high data byte in two-s complement format and is fixed at –15 (decimal). The remaining 11 bits in two's complement binary format represent the mantissa.

The current measurement accuracy is also improved by each module being calibrated during manufacture with the offset in the current reading. The IOUT_CAL_OFFSET command is used to store and read the current offset. The argument for this command consists of two bytes composed of a 5-bit exponent (fixed at -4d) and a 11-bit mantissa. This command has a resolution of 62.5mA and a range of -4000mA to +3937.5mA. During manufacture, each module is calibrated by measuring and storing the current gain factor and offset into non-volatile storage.

The READ_IOUT command provides module average output current information. This command only supports positive or current sourced from the module. If the converter is sinking current a reading of 0 is provided. The READ_IOUT command returns two bytes of data in the linear data format. The exponent uses the upper five bits [7:3] of the high data byte in two-s complement format and is fixed at –4 (decimal). The remaining 11 bits in two's complement binary format represent the mantissa with the 11th bit fixed at 0 since only positive numbers are considered valid.

Note that the current reading provided by the module is not corrected for temperature. The temperature

corrected current reading for module temperature $T_{\mbox{\scriptsize Module}}$ can be estimated using the following equation

I_{rear_out}]+[(T_{IND}-30) X 0.00393]

where I_{OUT_CORR} is the temperature corrected value of the current measurement, I_{READ_OUT} is the module current measurement value, T_{IND} is the temperature of the inductor winding on the module. Since it may be difficult to measure T_{IND} , it may be approximated by an estimate of the module temperature.

Measuring Output Voltage Using the PMBus

IOUT,CORR

The module can provide output voltage information using the READ_VOUT command. The command returns two bytes of data all representing the mantissa while the exponent is fixed at -10 (decimal). During manufacture of the module, offset and gain correction values are written into the non-volatile memory of the module. The command VOUT_CAL_OFFSET can be used to read and/or write the offset (two bytes consisting of a 16- bit mantissa in two's complement format) while the exponent is always fixed at -10 (decimal). The allowed range for this offset correction is -125 to 124mV. The command VOUT_CAL_GAIN can be used to read and/or write the gain correction - two bytes consisting of a five-bit exponent (fixed at -8) and a 11-bit mantissa. The range of this correction factor is -0.125V to +0.121V, with a resolution of 0.004V. The corrected output voltage reading is then given by:

Measuring Input Voltage Using the PMBus

The module can provide output voltage information

V_{OUT} (Final) = [V_{OUT} (Initial) X (1 + VOUT_CAL_GAIN)] + VOUT_CAL_OFFSET

using the READ_VIN command. The command returns two bytes of data in the linear format. The upper five bits [7:3] of the high data form the two's complement representation of the exponent which is fixed at –5 (decimal). The remaining 11 bits are used for two's complement representation of the mantissa, with the 11th bit fixed at zero since only positive numbers are valid.



Measuring Input Voltage Using the PMBus (continued)

During module manufacture, offset and gain correction values are written into the non-volatile memory of the module. The command VIN_CAL_OFFSET can be used to read and/or write the offset -two bytes consisting of a five-bit exponent (fixed at -5) and all-bit mantissa in two's complement format. The allowed range for this offset correction is -2 to 1.968V, and the resolution is 32mV. The command VIN_CAL_GAIN can be used to read and/or write the gain correction - two bytes consisting of a five-bit exponent (fixed at -8) and a 11-bit mantissa. The range of this correction factor is -0.125V to +0.121V, with a resolution of 0.004V. The corrected output voltage reading is then given by:

 $V_{\text{IN}} \text{(Final)} = [V_{\text{IN}} \text{(Initial)} X (1 + \text{VIN}_CAL_GAIN)] + \\ VIN_CAL_OFFSET$

Reading the Status of the Module using the PMBus

The module supports a number of status information commands implemented in PMBus. However, not all features are supported in these commands. Al in the bit position indicates the fault that is flagged.

STATUS_BYTE : Returns one byte of information with a summary of the most critical device faults

Bit Position	Flag	Default Value
7	Х	0
6	OFF	0
5	Vout Overvoltage	0
4	I _{out} Overcurrent	0
3	V _{IN} Undervoltage	0
2	Temperature	0
1	CML (Comm. Memory Fault)	0
0	None of the above	0

Bit Position	Flag	Default Value
7	Х	0
6	OFF	0
5	V _{OUT} Overvoltage	0
4	I _{OUT} Overcurrent	0
3	V _{IN} Undervoltage	0
2	Temperature	0
1	CML (Comm. Memory Fault)	0
0	None of the above	0

Low Byte

Bit Position	Flag	Default Value
7	Vout fault or warning	0
6	lout fault for warning	0
5	Х	0
4	Х	0
3	Power_GOOD# (is negated)	0
2	Х	0
1	Х	0
0	Х	0

High Byte

STATUS_WORD : Returns two bytes of information with a summary of the module's fault/warning conditions.

Bit Position	Flag	Default Value
7	Vout OV Fault	0
6	Х	0
5	Х	0
4	Vout UV Fault	0
3	Х	0
2	Х	0
1	Х	0
0	Х	0

STATUS_VOUT : Returns one byte of information relating to the status of the module's output voltage related faults.

Bit Position	Flag	Default Value
7	Iout OC Fault	0
6	Х	0
5	Iout OC Warning	0
4	Х	0
3	Х	0
2	Х	0
1	Х	0
0	Х	0

STATUS_IOUT : Returns one byte of information relating to the status of the module's output voltage related faults.

Bit Position	Flag	Default Value
7	OT Fault	0
6	OT Warning	0
5	Х	0
4	Х	0
3	Х	0
2	Х	0
1	Х	0
0	Х	0



Measuring Input Voltage Using the PMBus (continued)

STATUS_CML : Returns one byte of information relating to the status of the module's communication related faults.

Bit Position	Flag	Default Value
7	Invalid/Unsupported Command	0
6	Invalid/Unsupported Command	0
5	Packet Error Check Failed	0
4	Х	0
3	Х	0
2	Х	0
1	Other Communication Fault	0
0	Х	0

MFR_VIN_MIN : Returns minimum input voltage as two data bytes of information in Linear format (upper five bits are exponent – fixed at -2, and lower 11 bits are mantissa in two's complement format – fixed at 12)

MFR_VOUT_MIN: Returns minimum output voltage as two data bytes of information in Linear format (upper five bits are exponent – fixed at -10, and lower 11 bits are mantissa in two's complement format – fixed at 614)

MFR_SPECIFIC_00: Returns information related to the type of module and revision number. Bits [7:2] in the Low Byte indicate the module type (000000 corresponds to the PDT012 series of module). Bits 1:0 in the High Byte are used to indicate the manufacturer ID, with 00 reserved for OmniOn Power™.

Bit Position	Flag	Default Value
7:2	Module Name	000000
1:0	Reserved	10
	Low Byte	

Bit Position	Flag	Default Value
7:0	Module Revision Number	None
1:0	Reserved	000
	Link Date	



Summary of Supported PMBus Commands

Please refer to the PMBus 1.1 specification for more details of these commands.

Hex Code	Command		Brief Description Furn Module on or off. Also used to margin the output voltage											
		Turn Module o	n or o	ff. Also	o used t	o marg	jin the	e outp	ut vol	ltage				
01	ODEDATION	Format Bit Position	7	6	Un 5	signed 4	Bina 3	y 2	1	0				
01	OPERATION	Access	r/w	r	r/w	r/w	r/w	r/w	r	r				
		Function	On	X		Marg	-		X	X				
		Default Value		0	0	0	0	0	X	Х	-			
		Configures the analog ON/OF			MBus c	ommai	nds		ion of					
		Format				signed	1	Y						
02	ON_OFF_CONFIG	Bit Position	7	6	5	4	3	2	1	0	YES			
		Access Function	r X	r X	r X	r/w pu	r/w cmd	r/w	r/w pol	r				
		Default Value		0	0	1	0	cpr 1	1	cpa 1				
03	CLEAR_FAULTS	Clear any fault SMBALERT# si	bits t		ay have		set, als			the				
			-					-		the				
		current registe matches the va	Used to control writing to the module via PMBus. Copies the current register setting in the module whose command code natches the value in the data byte into non-volatile memory EEPROM) on the module											
		Format			Uns	signed	Binar	У						
		Bit Position	7	6	5	4	3	2	1	0				
		Access	r/w	r/w	r/w	Х	Х	<u>X</u>	Х	X				
		Function	bit7	bit6	bit5	Х	Х	Х	Х	Х				
		Default Val-	0	0	0	Х	Х	Х	Х	Х				
10	WRITE_PROTECT	Bit5: 0 – Enable 1 – Disabl OPERATION ar	es all nd	writes	except	t the W	RITE_I	PROT			YES			
		ON_OFF							_					
		Bit 6: 0 – Enabl 1 – Disabl OPERATION								CT and				
		commar	nds (bi	t5 anc	l bit7 m	nust be	O)							
		Bit7: 0 – Enabl	es all '	writes	as peri	mitted	in bit5	or bi	t6					
		1 – Disabl					e WRI	re_pr	OTEC	CT.				
		command (bit Copies all curre				,	mad	ulaint	tonor	2-				
11	STORE_DEFAULT_ALL	volatile memo	ry (EE	PROM	I) on th									
12	RESTORE_DEFAULT_ALL	Restores all cu in the module	rrent i	registe	er settir	-			from	values				
13		Copies the cur command cod volatile memo	rent re le mat	egiste ches t	r settin the valu	g in the ue in th	e mod e data	ule w		non-				
15	STORE_DEFAULT_CODE	Bit Position 7 6 5 4 3 2 1 0												
		Access	W	W	W	W	W	W	W	W				
		Function			Co	mman	a Cod	e						

Table 6



Hex Code	Command			Brie	ef Deso	criptio	n				Non-Volatile Memory Storage
1/		Restores the co command cod value in the ma	le ma	tches t	he val	ue in th	ne data	a byte	from		
14	RESTORE_DEFAULT_CODE	Bit Position	7	6	5	4	3	2	1	0	
		Access	W	W	W	W	\sim	W	W	W	
		Function			Co	mman	id Cod	е			
		The module ha These values c					d Expo	nent	set to	-10.	
20	VOUT_MODE	Bit Position	7	6	5	4	3	2	1	0	
20	VOOT_MODE	Access	r	r	r	r	r	r	r	r	
		Function		Mode	-			oner	nt	1	
		Default Value	0	0	0	1	0	1	1	0	
		Apply a fixed o value. Exponer		xed at	-10.	-				nd	
		Format		Linea	ar, two	o's com	-	ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r/w	r	r/w	r/w	r/w	r/w	r/w	r/w	
22	VOUT_TRIM	Function			1	High I	Byte	1	1		YES
		Default Value	0	0	0	0	0	0	0	0	
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
		Function				Low E	<u> </u>				
		Default Value		0	0	0	0	0	0	0	
		Sets the target Exponent is fix			margi	ning th	ie outp	but hig	gh.		
		Format		Linea	ar, two	o's com	pleme	ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
25	VOUT_MARGIN_HIGH	Function		1	T	High I		r	r	r	YES
		Default Value		0	0	0	0	1	0	1	
		Bit Position	7	6	5	4	3	2		0	
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
		Function		-		Low E		-	-	1	
		Default Value		1	0	0	0	1	1	1	
		Sets the target is fixed at -10.	: volta	-						onent	
		Format		Linea		o's com	-		nary		
		Bit Position	7	6	5	4	3	2	1	0	
_		Access	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
26	VOUT_MARGIN_LOW	Function		-	-	High I	-	-	-	-	YES
		Default Value		0	0	0	0		0	0	
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
		Function Default Value	0	٦	0	Low E	1	0	0	1	
			U	I	U	I	0	U	U		



Hex Code	Command			Brie	ef Deso	criptio	n				Non-Volatile Memory Storage
		Sets the scaling resistor divider			out vol	tage –	equal [.]	to the	feed	back	
		Format		Line	ar. two	o's com	pleme	ent bi	narv		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r/w	r/w	
29	VOUT_SCALE_LOOP	Function		E	xpone			M	1antis		YES
		Default Value	1	0	1	1	1	0	0	1	
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
		Function				Mant	issa				
		Default Value	0	0	0	0	0	0	0	0	
		Sets the value	ofinp	ut volt	age at	which	the m	odule	e turns	s on.	
		Format		Linea	ar, two	o's com	pleme	ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	
35	VIN_ON	Function		E	xpone	ent		M	lantis	sa	YES
55		Default Value	l	1	1	1	0	0	0	0	TES
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
		Function				Mant	issa				
		Default Value	0	0	0	0	1	0	1	1	
		Sets the value	ofinp	ut volt	age at	which	the m	odule	e turns	s off.	
		Format		Linea	ar, two	o's com	pleme	ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	
36	VIN_OFF	Function		E	xpone	ent		M	lantis	sa	YES
30	VIIN_OFF	Default Value	1	1	1	1	0	0	0	0	TES
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
		Function		1		Mant	issa			r	
		Default Value	0	0	0	0	1	0	1	0	
		Returns the va the measured		-		rection	term	used [.]	to cor	rect	
			ουιρι								
		Format				o's com	-		nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r/w	
38	IOUT_CAL_GAIN	Function	-	1	xpone		-		1antis:	1	YES
		Default Value		0	0	0		0	0	V	
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	
		Function Default Value	<u>۱</u>	/· \/aria	hla ha	Mant sed on		Vealil	oratio	n	
				v. vdiid		seu on	iactor	y call	oratio	11	



Hex Code	Command			Non-Volatile Memory Storage								
		Returns the va the measured				orrectio	n term	n usec	l to co	orrect		
		Format		Linea	ar, two	o's com	pleme	ent bi	nary			
		Bit Position	7	6	5	4	3	2	1	0		
		Access	r	r	r	r	r	r/w	r	r		
39	IOUT_CAL_OFFSET	Function		E	Expone	ent		N	1antis:	sa	YES	
35		Default Value	1	1	1	0	0	V	0	0	120	
		Bit Position	7	6	5	4	3	2	1	0		
		Access	r	r	r/w	r/w	r/w	r/w	r/w	r/w		
		Function		1	1	Mant	issa					
		Default Value	0	0	V	Variab	ole base	ed on	facto	ry		
		is fixed at -10. changed for di	Sets the voltage level for an output overvoltage fault. Exponent s fixed at -10. Suggested value shown for 1.2Vo. Should be changed for different output voltage. Values can be 108%, 110%, 12% or 115% of output voltage									
		Format		Linea	ar, two	o's com	pleme	ent bi	nary			
		Bit Position	7	6	5	4	3	2	1	0		
40	VOUT_OV_FAULT_LIMIT	Access	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	YES	
		Function				High I	Byte					
		Default Value	0	0	0	0	0	1	0	1		
		Bit Position	7	6	5	4	3	2	1	0		
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w		
		Function		_	-	Low E						
		Default Value	0	1	1	0	0	0	0	0		
		Instructs the m output overvol			hat ac	tion to	take ir	n resp	onse t	to a		
		Format			Un	signed	l Binar	v				
(1	VOUT_OV_FAULT_RESPONS		7	6	5	4	3	2	1	0	VEC	
41	E	Access	r/w	r/w	r/w	r/w	r/w	r	r	r	YES	
		Function	RSP [1]	RSP [0]	RS[2]	RS[1]	RS[0]	х	х	х		
		Default Value	1	1	1	1	1	1	0	0		
				l for a		ut und			-	, v		
		Sets the voltage level for an output undervoltage fault. Exponent is fixed at -10. Suggested value shown for 1.2Vo. Should be changed for different output voltage. Values can be 92%, 90%, 88% or 85% of output voltage										
		Format		Linea	ar, two	's com	pleme	ent bi	nary			
		Bit Position	7	6	5	4	3	2	1	0		
44	VOUT_UV_FAULT_LIMIT	Access	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	YES	
		Function				High l	· ·					
		Default Value		0	0	0	0	1	0	0		
		Bit Position	7	6	5	4	3	2		0		
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w		
		Function Default Value	0	0	1	Low k	Jyre	0	0	1		
		Delault value	0	0				0	0			



Hex Code	Command			Brie	ef Desc	cription	า				Non-Volatile Memory Storage
		Instructs the m output underv			hat ac	tion to	take ir	ı resp	onse t	o a	Memory Storage
		Format			Un	signed	Bina	rv			
		Dit Desitien	7	6	5	4	3	2	1	0	
45	VOUT_UV_FAULT_RESPONSE	Access	r/w	r/w	r/w	r/w	r/w	r	r	r	YES
		Function	RSP [1]	RSP [0]	RS[2]		RS[0]	×	x	x	-
		Default Value	0	0	0	0	0	1	0	0	
		Sets the outpu changed)	t over	currer	nt fault	level ir	ח A (ca	nnot	be		
		Format		Line	ar, two	o's com		ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	
46	IOUT_OC_FAULT_LIMIT	Function			Expone		-		1antis:		YES
		Default Value	1	1	1	1	1	0	0	0	-
		Bit Position	7	6	5	4	3	2	1	0	-
		Access	r	r	r	r	r	r	r	R	4
		Function Default Value	0	0	0	Mant 1	issa ı	1	1	1	-
				-		I		I	I	I	
		Sets the outpu Format	t over			o's com			narv		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	-
		Function		E	xpone	ent		N	antis	sa	
4A	IOUT_OC_WARN_LIMIT	Default Value	1	1	1	1	1	0	0	0	YES
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r/w	r/w	r/w	r/w	r/w	r/w	
		Function		-	_	Mant	issa	-			
		Default Value	0	0	0	1	1	1	0	1	
		Sets the outpu asserted high.					ne PGC	DOD þ	oin is		
			Expo								
		Format	-		· ·	o's com				0	
		Bit Position Access	7 r	6 r/w	5 r/w	4 r/w	3 r/w	2 r/w	1 r/w	0 r/w	4
		Function	ſ	I/VV	I/VV	High		1/7	I/VV	1/ 77	-
5E	POWER_GOOD_ON	Default Value	0	0	0	нign 0	oyte 0	1	0	0	YES
		Bit Position	7	6	5	4	3	2	1	0	1
		Access	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	1
		Function	., ••	., ••	'/ **	Low		., ••	.,	., ••	1
		Default Value	0	1	1	0	1	0	1	0	1
					·			-		-	



Hex Code	Command			:	Brief D	escri	otion				Non-Volatile Memory Storage	
code		Sets the outp asserted low.						PGOOI) pin	is de-	Memory Storage	
		Format						ement	hinar	v		
		Bit Position	1 7					3 2	_	y 0		
		Access		,				/w r/				
5F	POWER_GOOD_OFF	Function	-	17			igh Byt		/ 1/	1/00	YES	
		Default Valu	e C					0 1	() ()		
		Bit Position					4	3 2	. 1	0		
		Access	r/v	w r/	w r/	w r	/w r	/w r/	∧ r/	w r/w		
		Function				L	ow byt	e				
		Default Valu	e C) [()	1	0 0) 1	0		
		Sets the rise	time	ofthe	outpu	ut volta	age du	ring sta	artup.	<u>.</u>	<u> </u>	
		Format										
		Bit Position	n 7	7 6	5 !	5	4	3 2		0		
		Access	1	·	r	r	r	r ı	·	r r/w		
61	TON_RISE	Function			Expo	onent			Man	tissa	YES	
01	ION_RISE	Default Valu	e 1	-			-	0 () ()	TES	
		Bit Position						3 2		0		
		Access	r/	w r/	w r/	w r	/w r	/w r/	∧ r/	w r/w		
		Function				N	1antiss	а				
		Default Valu	e () ()	1	0	1 ()	1		
		Returns one critical modu			ormatio	on wit	h a sur	mmary	ofthe	e most		
		Format				Unsig	ned B	inary				
78	STATUS_BYTE	Bit Position	7	6	5	4	3	2	1	0		
70	STATUS_BITE	Access	r	r	r	r	r	r	r	r		
		Flag	Х	OFF	Vout ov	IOUT O	c Vin uv		CML	OTHER		
		Default Valu	e 0	0	0	0	0	0	0	0		
					_			•		•	4	
		Returns two module's fau					ith a su	ımmar	y of th	ie		
		Format			L	Jnsigr	ned Bir	nary				
		Bit Position	7	6	5	4	3	2	1	0		
		Access	r	r	r	r	r	r	r	r]	
		Flag	Vout	I _{OUT_OC}	Х	Х	PGOO	х с	Х	Х		
79	STATUS_WORD	Default	0	0	0	0	0	0	0	0		
		Bit Position	7	6	5	4	3	2	1	0	1	
		Access	r	r	r	r	r	r	r	r	1	
		Flag	Х	OFF	V _{out_o'}			v TEMI	СМІ		2	
		Default	0	0	0	0	0	0	0	0]	



Hex Code	Command		Brief Description Returns one byte of information with the status of the											
		Returns one module's out						stati	us of	the		Memory Storage		
		Format			Un	sigr	ned B	Binar	У					
7A	STATUS_VOUT	Bit Position	7	6		5	4	2		2 1	0			
10	514105_0001	Access	r	r		r	r	r		r r				
		Flag	V _{OUT_OV}	Х		Х	V _{OUT_}	_uv X		x x	Х			
		Default Value	0	0		0	0	C) (0 0	0			
		Returns one module's out			lated	fau	lts			the				
		Format												
70		Bit Position	Bit Position 7 6 5 4 3 2 1 0 Access r											
7B	STATUS_IOUT													
		Flag												
		Default	0	0	0	(0	0	0	0	0			
			Returns one byte of information with the status of the nodule's temperature related faults											
		Format			Un	sigr	ned E	Binar	У					
		Bit Position	7	6		5	4	3	2	1	0			
7D	STATUS_TEMPERATURE	Access	r	r		r	r	r	r	r	r			
		Flag	OT_FAI LT	OT. WAF		Х	Х	Х	Х	Х	Х			
		Default	0	0		0	0	0	0	0	0			
		Returns one module's cor						stati	us of	the				
		Format			Un	sigr	ned B	Binar	У					
		Bit Position	7	6	5		4	3	2	1	0			
		Access	r	r	r		r	r	r	r	r			
7E	STATUS_CML	Flag	Invalid Comma nd		PE Fa		x	х		Other Com m	Х			
		Default	0	0	0		0	0	0	0	0			
		Returns the value of the input voltage applied to the module												
		Format		Linea	ar, two	o's (comp	blem	ent b	binary				
		Bit Position	า 7	6	5		4	3	2	1	0			
		Access	r	r	r		r	r	r	r	r			
88	READ_VIN	Function	<u> </u>	E	xpone	ent	<u>, </u>	-		Mantis				
		Default Valu			0			7	0	0	0			
		Bit Position Access	<u>ז 7</u> r	6 r	5 r		4 r	3 r	2 r	1 r	0 r			
		Function		I			ı 1antis		1 1		1			
		Default Valu	ie 0	0	0	1	0	0	0	0	0			
		ľ				· · · · ·			•			1		



Hex Code	Command			Brie	f Desc	criptior	า				Non-Volatile Memory Storage
		Returns the val	lue of	the ou	itput v	oltage	ofthe	mod	ule.		
		Format		Line	ar two	o's com	nlem	ant hi	narv		
		Bit Position	7	6	5	4	3	2	liai y	0	
		Access	r	r	r	r	r	r	r	r	
8B	READ_VOUT	Function				Manti	issa				
OD		Default Value	0	0	0	0	0	0	0	0	
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	
		Function Default Value	0	0	0	Manti 0	issa 0	0	0	0	
			-	-	-	-		-	-	0	
		Returns the val	lue of	the ou	itput c	urrent	ofthe	mod	ule		
		Format		Linea	ar, two	's com	pleme	ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	
8C	READ_IOUT	Function			xpone		-		1antis		
		Default Value	1	1		0	0	0	0	0	
		Bit Position Access	7 r	6 r	5 r	4 r	3 r	2 r	1 r	0 r	
		Function	1	I		Manti	-			- 1	
		Default Value	0	0	0	0	0	0	0	0	
		Returns one by Spec. 1.1 (read c		dicatin	-			·	nt to P	PMBus	5
98	PMBUS_REVISION	Format Bit Position	7	6	5	signed 4	3	y 2	1	0	YES
		Access	r	r	r	r	r	r	r	r	
		Default Value	0	0	0	1	0	0	0	1	
		Returns the mi operate at (read			ut volta	age the	e modi	ule is :	specif	ied to	
		Format		Linea	ar, two	's com	pleme	ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	VEC
AO	MFR_VIN_MIN	Function	1		Expone	ent 1	0		/antis		YES
		Default Value Bit Position	7	6	5	4	0 3	0	0	0	
		Access	r	r	r	r	r	r	r	r	
		Function	· ·			Manti				<u> </u>	
		Default Value	0	0	0	0	1	1	0	0	
		Returns the mi module (read c				0 1					
		Format	-			o's com			nary	~	
		Bit Position	7	6	5	4 r	3	2		0	
A4	MFR_VOUT_MIN	Access Function	r	r	r	r	r	r N	r ∕lantis	r	YES
/ \ f		Default Value	0	0	0	0	0	0	1	0	
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r	r	r	r	r	
		Function				Mant	issa			•	
		Default Value	0	1	1	0	0	1	1	0	



Code				Brie	et Dese	criptior	ר				Non-Volatile Memory Storage	
		Returns modul	e nar	ne info	rmatio	on (read	d only)				Memory Storage	
						•	• • •					
		Format		C		signec			1	0		
		Bit Position Access	7 r	6 r	5 r	4 r	3 r	2 r	1 r	0 r		
		Function	I		I	Reser	I	I	I	Ι		
DO	MFR_SPECIFIC_00	Default Value	0	0	0	0	0	0	0	0	YES	
		Bit Position	7	6	5	4	3	2	1	0		
		Access	r	r	r	r	r	r	r	r		
		Function		1	Modul	e Name	e		Rese	erved		
		Default Value	0	0	0	0	0	0	1	0		
		Applies an offse										
		calibrate out of										
		output voltage at -10.	utput voltage (between -125mV and +124mV) Exponent is fixed									
				1 *								
		Format Bit Position	7	6	ar, two 5	o's com 4	pleme 3	2	nary	0		
D4	VOUT CAL OFFSET	Access	r/w	r	r	r r	r	∠ r	r	r	YES	
04	VOUT_CAL_OFFSET	Function	1/ VV		I	Mant		I			TES	
		Default Value	V	0	0	0	0	0	0	0		
		Bit Position	7	6	5	4	3	2	1	0		
		Access	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w		
		Function				Mant	issa					
		Default Value	V	V	V	V	V	V	V	V		
		Applies a gain (
		to calibrate out						ement	s of th	ne		
		output voltage	(betv	veen -().125 ai	nd 0.121)					
		Format		Linea	ar, two	o's com	pleme	ent bi	nary			
		Bit Position	7	6	5	4	3	2	1	0		
D5	VOUT_CAL_GAIN	Access	r	r	r	r	r	r/w	r	r	YES	
		Function		1	xpone				1antis			
		Default Value	1	1	0	0	0	0	0	V		
		Bit Position Access	7 r	6 r	5 r	4 r/w	3 r/w	2 r/w	r/w	0 r/w		
		Function	-	1	1	Mant		1/ VV	1/ VV	1/ VV		
		Default Value	V	V	V	V	V	V	V	V		
		Applies an offse										
		to calibrate out offset errors in module measurements of the input voltage (between -2V and +1.968V)										
						o's com		ant bi				
		Format Bit Position	7	6	ar, two	4 4	jpleme 3	2 2	nary 1	0		
		Access	/ r	r r	r r	r r	r	∠ r/w	r	R		
D6	VIN_CAL_OFFSET	Function	•		xpone		l 1		lantis		YES	
		Default Value	1	1	0	1	V	0	0	V		
		Bit Position	7	6	5	4	3	2	1	0		
		Access	r	r	r/w	r/w	r/w	r/w	r/w	r/w		
		Function				Mant	1					
		Default Value	0	0	V	V	V	V	V	V		



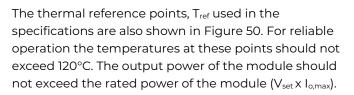
Hex Code	Command			Non-Volatile Memory Storage							
		Applies a gain o calibrate out ga voltage (betwe	ain er	rors in	modu	le meas					
		Format		Linea	ar, two	o's com	pleme	ent bi	nary		
		Bit Position	7	6	5	4	3	2	1	0	
D7	VIN CAL GAIN	Access	r	r	r	r	r	r/w	r	r	YES
		Function		E	xpone	ent		m	nantis	sa	
		Default Value	1	1	0	0	V	0	0	V	
		Bit Position	7	6	5	4	3	2	1	0	
		Access	r	r	r	r/w	r/w	r/w	r/w	r/w	
		Function				Mant	issa				
		Default Value 0 0 V V V							V		



Thermal Considerations

Power modules operate in a variety of thermal environments; however, sufficient cooling should always be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel. The test set-up is shown in Figure 49. The preferred airflow direction for the module is in Figure 50.



Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

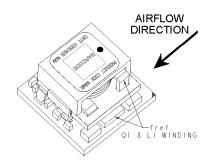


Figure 50. Preferred airflow direction and location of hot- spot of the module (T_{ref}).

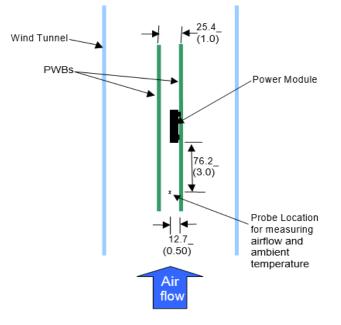


Figure 49. Thermal Test Setup.



Shock and Vibration

The ruggedized (-D version) of the modules are designed to withstand elevated levels of shock and vibration to be able to operate in harsh environments. The ruggedized modules have been successfully tested to the following conditions:

Non operating random vibration:

Random vibration tests conducted at 25°C, 10 to 2000Hz, for 30 minutes each level, starting from 30Grms (Z axis) and up to 50Grms (Z axis). The units were then subjected to two more tests of 50Grms at 30 minutes each for a total of 90 minutes.

Operating shock to 40G per Mil Std. 810G, Method 516.4 Procedure I:

The modules were tested in opposing directions along each of three orthogonal axes, with waveform and amplitude of the shock impulse characteristics as follows:

All shocks were half sine pulses, 11 milliseconds (ms) in duration in all 3 axes.

Units were tested to the Functional Shock Test of MIL-STD-810, Method 516.4, Procedure I - Figure 516.4-4. A shock magnitude of 40G was utilized. The operational units were subjected to three shocks in each direction along three axes for a total of eighteen shocks.

Operating vibration per Mil Std 810G, Method 514.5 Procedure I:

The ruggedized (-D version) modules are designed and tested to vibration levels as outlined in MIL-STD-810G, Method 514.5, and Procedure 1, using the Power Spectral Density (PSD) profiles as shown in Table 7 and Table 8 for all axes. Full compliance with performance specifications was required during the performance test. No damage was allowed to the module and full compliance to performance specifications was required when the endurance environment was removed. The module was tested per MIL-STD- 810, Method 514.5, Procedure I, for functional (performance) and endurance random vibration using the performance and endurance levels shown in Table 7 and Table 8 for all axes. The performance test has been split, with one half accomplished before the endurance test and one half after the endurance test (in each axis). The duration of the performance test was at least 16 minutes total per axis and at least 120 minutes total per axis for the endurance test. The endurance test period was 2 hours minimum per axis.

Frequency (Hz)	PSD Level (G2/Hz)	Frequency (Hz)	PSD Level (G2/Hz)	Frequency (Hz)	PSD Level (G2/Hz)
10	1.14E-03	170	2.54E-03	690	1.03E-03
30	5.96E-03	230	3.70E-03	800	7.29E-03
40	9.53E-04	290	7.99E-04	890	1.00E-03
50	2.08E-03	340	1.12E-02	1070	2.67E-03
90	2.08E-03	370	1.12E-02	1240	1.08E-03
110	7.05E-04	430	8.84E-04	1550	2.54E-03
130	5.00E-03	490	1.54E-03	1780	2.88E-03
140	8.20E-04	560	5.62E-04	2000	5.62E-04

Table 7: Performance Vibration Qualification - All Axes

Frequency (Hz)	PSD Level (G2/Hz)	Frequency (Hz)	PSD Level (G2/Hz)	Frequency (Hz)	PSD Level (G2/Hz)
10	0.00803	170	0.01795	690	0.00727
30	0.04216	230	0.02616	800	0.05155
40	0.00674	290	0.00565	890	0.00709
50	0.01468	340	0.07901	1070	0.01887
90	0.01468	370	0.07901	1240	0.00764
110	0.00498	430	0.00625	1550	0.01795
130	0.03536	490	0.01086	1780	0.02035
140	0.0058	560	0.00398	2000	0.00398





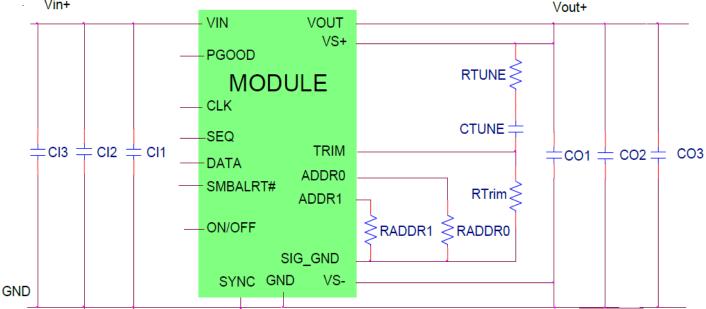
Example Application Circuit

Requirements:

- Vin: 12V
- V_{out}: 1.8V
- 9A max., worst case load transient is from 6A to 9A lout:
- 1.5% of Vout (27mV) for worst case load transient ΔV_{out} :

Vin, ripple 1.5% of Vin (180mV, p-p)





- CI1 Decoupling cap - 1x0.047µF/16V ceramic capacitor (e.g. Murata LLL185R71C473MA01)
- CI2 2x22µF/16V ceramic capacitor (e.g. Murata GRM32ER61C226KE20)
- CI3 470µF/16V bulk electrolytic
- CO1 Decoupling cap - 1x0.047µF/16V ceramic capacitor (e.g. Murata LLL185R71C473MA01)
- CO2 2 x 47µF/6.3V ceramic capacitor (e.g. Murata GRM31CR60J476ME19)
- 1 x 330µF/6.3V Polymer (e.g. Sanyo Poscap) CO3
- 3300pF ceramic capacitor (can be 1206, 0805 or 0603 size) C_{Tune}
- 270 ohms SMT resistor (can be 1206, 0805 or 0603 size) R_{Tune}
- RTrim $10k\Omega$ SMT resistor (can be 1206, 0805 or 0603 size, recommended tolerance of 0.1%)

Note: The DATA, CLK and SMBALRT pins do not have any pull-up resistors inside the module. Typically, the SMBus master controller will have the pull-up resistors as well as provide the driving source for these signals.



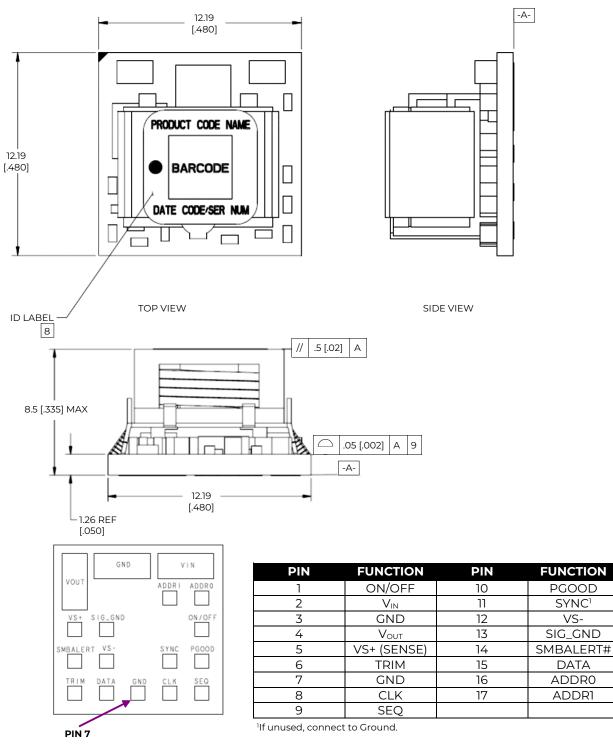


Mechanical Outline

Dimensions are in millimeters and (inches).

Tolerances: x.x mm ±0.5 mm (x.xx in. ± 0.02 in.) [unless otherwise indicated]

x.xx mm ± 0.25 mm (x.xxx in ± 0.010 in.)



BOTTOM VIEW

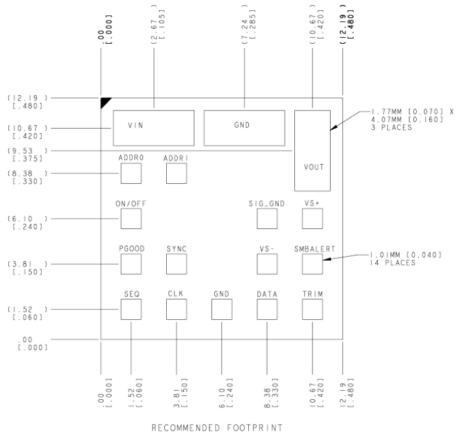


Recommended Pad Layout

Dimensions are in millimeters and (inches).

Tolerances: x.x mm ±0.5 mm (x.xx in. ± 0.02 in.) [unless otherwise indicated]

x.xx mm ± 0.25 mm (x.xxx in ± 0.010 in.)



RECOMMENDED FOOTPRINT -THROUGH THE BOARD-

PIN	FUNCTION	PIN	FUNCTION
1	ON/OFF	10	PGOOD
2	V _{IN}	11	SYNC ²
3	GND	12	VS-
4	V _{OUT}	13	SIG_GND
5	VS+ (SENSE)	14	SMBALERT#
6	TRIM	15	DATA
7	GND	16	ADDR0
8	CLK	17	ADDR1
9	SEQ		

²If unused, connect to Ground.

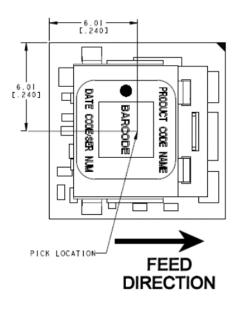


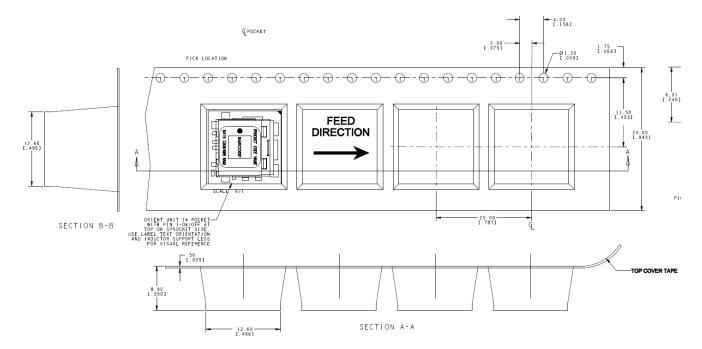


Packaging Details

The 12V Digital PicoDLynx[™] 12A modules are supplied in tape & reel as standard. Modules are shipped in quantities of 200 modules per reel.

All Dimensions are in millimeters and (in inches).





Reel Dimensions:

Outside Dimensions:	330.2 mm (13.00)
Inside Dimensions:	177.8 mm (7.00")
Tape Width:	24.00 mm (0.945")



Surface Mount Information

Pick and Place

The 12A Digital PicoDLynx[™] modules use an open frame construction and are designed for a fully automated assembly process. The modules are fitted with a label designed to provide a large surface area for pick and place operations. The label meets all the requirements for surface mount processing, as well as safety standards, and is able to withstand reflow temperatures of up to 300°C. The label also carries product information such as product code, serial number and the location of manufacture.

Nozzle Recommendations

The module weight has been kept to a minimum by using open frame construction. Variables such as nozzle size, tip style, vacuum pressure and placement speed should be considered to optimize this process. The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

Bottom Side / First Side Assembly

This module is not recommended for assembly on the bottom side of a customer board. If such an assembly is attempted, components may fall off the module during the second reflow process.

Lead Free Soldering

The modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

Pb-free Reflow Profile

Power Systems will comply with J-STD-020 Rev. D (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package (table 4-2). The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Fig. 51. Soldering outside of the recommended profile requires testing to verify results and performance.

MSL Rating

The 12A Digital Pico DLynx[™] modules have a MSL rating of 2a

Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/ Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of \leq 30°C and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: $< 40^{\circ}$ C, < 90%relative humidity.



Figure 51. Recommended linear reflow profile using Sn/Ag/Cu solder.

Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to Board Mounted Power Modules: Soldering and Cleaning Application Note (AN04-001).



Ordering Information

Please contact your OmniOn Power™ Sales Representative for pricing, availability and optional features.

Device Code	Input Voltage Range	Output Voltage	Output Current	On/Off Logic	Sequencing	Ordering Code
PDT012A0X3-SRZ	3 – 14.4V _{dc}	0.45 – 5.5V _{dc}	12A	Negative	Yes	CC109159661
PDT012A0X3-SRDZ	3 – 14.4V _{dc}	0.45 – 5.5V _{dc}	12A	Negative	Yes	CC109168836
PDT012A0X43-SRZ	3 – 14.4V _{dc}	0.45 – 5.5V _{dc}	12A	Positive	Yes	CC109159678
PDT012A0X43-SRDZ	3 – 14.4V _{dc}	0.45 – 5.5V _{dc}	12A	Positive	Yes	CC109168844

-Z refers to RoHS compliant parts

Table 9. Device Codes

Package Identifier	Family	Sequencing Option	Output current	Output voltage	On/Off logic	Remote Sense	Ор	tions	RoHS Compliance
Р	D	Т	012A0	Х	4	3	-SR	-D	Z
P=Pico U=Micro M=Mega G=Giga	D=DLynx Digital V=DLynx Analog	T=with EZ Sequence X = without sequencing	12A	X = programma ble output	4 = Positive No entry = negative	3 = Remote Sense	S = Surface Mount R = Tape & Reel	D = 105°C operating ambient, 40G operating shock as per MIL Std	Z = RoHS6

Table 10. Coding Scheme

OmniOn Power™ digital non-isolated DC-DC products may be covered by one or more of the following patents licensed from Bel Power Solutions, Inc.: US20040246754, US2004090219A1, US2004093533A1, US2004123164A1, US2004123167A1, US2004178780A1, US2004179382A1, US20050200344, US20050223252, US2005289373A1, US20060061214, US2006015616A1, US20060174145, US20070226526, US20070234095, US20070240000, US20080052551, US20080072080, US20080186006, US6741099, US6788036, US6936999, US6949916, US7000125, US7049798, US7068021, US7080265, US7249267, US7266709, US7315156, US7372682, US7373527, US7394445, US7456617, US7459892, US7493504, US7526660.

Outside the US Bel Power Solutions, Inc. licensed technology is protected by patents: AU3287379AA,

AU3287437AA, AU3290643AA, AU3291357AA, CN10371856C, CN1045261OC, CN10458656C, CN10459360C, CN10465848C, CN11069332A, CN11124619A, CN11346682A, CN1685299A, CN1685459A, CN1685582A, CN1685583A, CN1698023A, CN1802619A, EP1561156A1, EP1561268A2, EP1576710A1, EP1576711A1, EP1604254A4, EP1604264A4, EP1714369A2, EP1745536A4, EP1769382A4, EP1899789A2, EP1984801A2, W004044718A1, W004045042A3, W004045042C1, W004062061A1, W004062062A1, W004070780A3, W004084390A3, W004084391A3, W005079227A3, W005081771A3, W006019569A3, W02007001584A3, W02007094935A3

Contact Us

For more information, call us at

+1-877-546-3243 (US)

+1-972-244-9288 (Int'l)



Change History (excludes grammar & clarifications)

Revision	Date	Description of the change
9.2	05/12/2022	Updated as per template
9.3	06/26/2023	Correction in values in characteristic curves on page - 10 and 11
9.4	11/01/2023	Updated as per OmniOn Power™ template



OmniOn Power Inc.

601 Shiloh Rd. Plano, TX USA

omnionpower.com

We reserve the right to make technical changes or modify the contents of this document without prior notice. OmniOn Power[™] does not accept any responsibility for errors or lack of information in this document and makes no warranty with respect to and assumes no liability as a result of any use of information in this document. We reserve all rights in this document and in the subject matter and illustrations contained therein. Any reproduction, disclosure to third parties or utilization of its contents – in whole or in parts – is forbidden without prior written consent of OmniOn Power[™]. This document does not convey license to any patent or any intellectual property right. Copyright© 2024 OmniOn Power Inc. All rights reserved.